

# 10-Bit, Multichannel ADCs/DACs with FIFO, Temperature Sensing, and GPIO Ports 

## General Description

The MAX1040-MAX1043/MAX1046-MAX1049 integrate a multichannel, 10-bit, analog-to-digital converter (ADC) and a quad, 10-bit, digital-to-analog converter (DAC) in a single IC. The devices also include a temperature sensor and configurable general-purpose I/O ports (GPIOs) with a 25 MHz SPI ${ }^{\text {TM }}$-/QSPITM-/MICROWIRE ${ }^{\text {TM }}$-compatible serial interface. The ADC is available in a 4 or an 8 inputchannel version. The four DAC outputs settle within $2.0 \mu \mathrm{~s}$, and the ADC has a 300 ksps conversion rate.
All devices include an internal reference ( 2.5 V or 4.096 V ) providing a well-regulated, low-noise reference for both the ADC and DAC. Programmable reference modes for the ADC and DAC allow the use of an internal reference, an external reference, or a combination of both. Features such as an internal $\pm 1^{\circ} \mathrm{C}$ accurate temperature sensor, FIFO, scan modes, programmable internal or external clock modes, data averaging, and AutoShutdown ${ }^{\text {TM }}$ allow users to minimize both power consumption and processor requirements. The low glitch energy ( 4 nV .s ) and low digital feedthrough ( $0.5 \mathrm{nV} \cdot \mathrm{s}$ ) of the integrated quad DACs make these devices ideal for digital control of fastresponse closed-loop systems.
The devices are guaranteed to operate with a supply voltage from +2.7V to +3.6V (MAX1041/MAX1043/MAX1047/ MAX1049) and from +4.75 V to +5.25 V (MAX1040/ MAX1042/MAX1046/MAX1048). These devices consume 2.5 mA at 300 ksps throughput, only $22 \mu \mathrm{~A}$ at 1 ksps throughput, and under $0.2 \mu \mathrm{~A}$ in the shutdown mode. The MAX1042/MAX1043/MAX1048/MAX1049 offer four GPIOs that can be configured as inputs or outputs.
The MAX1040-MAX1043/MAX1046-MAX1049 are available in 36 -pin thin QFN packages. All devices are specified over the $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ temperature range.

## Applications

Closed-Loop Controls for Optical Components and Base Stations

Features

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- 10-Bit, 300ksps ADC
Analog Multiplexer with True-Differential Track/Hold (T/H)
8 Single-Ended Channels or 4 Differential Channels (Unipolar or Bipolar)
4 Single-Ended Channels or 2 Differential Channels (Unipolar or Bipolar)
Excellent Accuracy: \(\pm 0.5\) LSB INL, \(\pm 0.5\) LSB DNL, No Missing Codes Over Temperature
- 10-Bit, Quad, \(2 \mu \mathrm{~s}\) Settling DAC
Ultra-Low-Glitch Energy (4nV.s)
Power-Up Options from Zero Scale or Full Scale Excellent Accuracy: \(\pm 0.5\) LSB INL
- Internal Reference or External Single-Ended/ Differential Reference
Internal Reference Voltage 2.5 V or 4.096 V
- Internal \(\pm 1^{\circ} \mathrm{C}\) Accurate Temperature Sensor
- On-Chip FIFO Capable of Storing 16 ADC
Conversion Results and One Temperature Result
- On-Chip Channel-Scan Mode and Internal Data-Averaging Features
- Analog Single-Supply Operation
+2.7 V to +3.6 V or +4.75 V to +5.25 V
- 25MHz, SPI/QSPI/MICROWIRE Serial Interface
- AutoShutdown Between Conversions
- Low-Power ADC
2.5 mA at 300 ksps
\(22 \mu \mathrm{~A}\) at 1 ksps
\(0.2 \mu \mathrm{~A}\) at Shutdown
- Low-Power DAC: \(1.5 \mu \mathrm{~A}\)
- Evaluation Kit Available (Order MAX1258EVKIT)
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SPI and QSPI are trademarks of Motorola, Inc. MICROWIRE is a trademark of National Semiconductor Corp. AutoShutdown is a trademark of Maxim Integrated Products, Inc.

Ordering Information/Selector Guide

| PART | TEMP RANGE | PIN-PACKAGE | REF <br> VOLTAGE <br> (V) | ANALOG <br> SUPPLY <br> VOLTAGE (V) | RESOLUTION <br> BITS*** | ADC <br> CHANNELS | DAC <br> CHANNELS | GPIOs |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |

${ }^{*}$ Future product-contact factory for availability.
**EP = Exposed pad.
${ }^{* * *}$ Number of resolution bits refers to both DAC and ADC.

Ordering Information/Selector Guide continued on last page.
Pin Configurations appear at end of data sheet.

## 10-Bit, Multichannel ADCs/DACs with FIFO, Temperature Sensing, and GPIO Ports

## ABSOLUTE MAXIMUM RATINGS

```
AVDD to AGND .......................................................-0.3V to +6 V
DGND to AGND....................................................-0.3V to +0.3 V
DVDD to \(A V_{D D} . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . .-3.0 V ~ t o ~+0.3 V ~\)
Digital Inputs to DGND............................................-0.3V to +6V
Digital Outputs to DGND ........................-0.3V to (DVDD + 0.3V)
Analog Inputs, Analog Outputs and REF
    to AGND..............................................-0.3V to (AV \(\mathrm{DD}+0.3 \mathrm{~V}\) )
Maximum Current into Any Pin (except AGND, DGND, AVDD,
DVDD, and OUT」
) ........................................................ 50 mA
```

|  |
| :---: |
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|  |  |

Note: If the package power dissipation is not exceeded, one output at a time can be shorted to $A V_{D D}, D V_{D D}$, $A G N D$, or DGND indefinitely.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## ELECTRICAL CHARACTERISTICS

$\left(A V_{D D}=D V_{D D}=2.7 \mathrm{~V}\right.$ to $3.6 \mathrm{~V}(\mathrm{MAX1041} / \mathrm{MAX1043} / \mathrm{MAX1047} / \mathrm{MAX1049})$, external reference $\mathrm{V}_{\mathrm{REF}}=2.5 \mathrm{~V}(\mathrm{MAX1041} / \mathrm{MAX1043} /$ MAX1047/MAX1049), $A V_{D D}=D V_{D D}=4.75 \mathrm{~V}$ to $5.25 \mathrm{~V}\left(\mathrm{MAX1040} / \mathrm{MAX1042/MAX1046/MAX1048)}\right.$ ) external reference $\mathrm{V}_{\text {REF }}=4.096 \mathrm{~V}$ (MAX1040/MAX1042/MAX1046/MAX1048), fSCLK $=4.8 \mathrm{MHz}\left(50 \%\right.$ duty cycle), $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$, unless otherwise noted. Typical values are at $A V_{D D}=D V_{D D}=3 V(M A X 1041 / M A X 1043 / M A X 1047 / M A X 1049), A V_{D D}=D V_{D D}=5 V(M A X 1040 / M A X 1042 /$ MAX1046/MAX1048), $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$. Outputs are unloaded, unless otherwise noted.)

| PARAMETER | SYMBOL | CONDITIONS | MIN TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| ADC |  |  |  |  |  |
| DC ACCURACY (Note 1) |  |  |  |  |  |
| Resolution |  |  | 10 |  | Bits |
| Integral Nonlinearity | INL |  | $\pm 0.5$ | $\pm 1.0$ | LSB |
| Differential Nonlinearity | DNL |  | $\pm 0.5$ | $\pm 1$ | LSB |
| Offset Error |  |  | $\pm 0.25$ | $\pm 2.0$ | LSB |
| Gain Error |  | (Note 2) | $\pm 0.025$ | $\pm 2.0$ | LSB |
| Gain Temperature Coefficient |  |  | $\pm 1.4$ |  | ppm/ ${ }^{\circ} \mathrm{C}$ |
| Channel-to-Channel Offset |  |  | $\pm 0.1$ |  | LSB |
| DYNAMIC SPECIFICATIONS (10kHz sine wave input, $\mathrm{V}_{\text {IN }}=2.5 \mathrm{~V}_{\text {P-P }}$ (MAX1041/MAX1043/MAX1047/MAX1049), $\mathrm{V}_{\text {IN }}=4.096 \mathrm{~V}_{\mathrm{P}-\mathrm{P}}$ (MAX1040/MAX1042/MAX1046/MAX1048), 300ksps, fSCLK $^{2}=4.8 \mathrm{MHz}$ ) |  |  |  |  |  |
| Signal-to-Noise Plus Distortion | SINAD |  | 61 |  | dB |
| Total Harmonic Distortion (Up to the Fifth Harmonic) | THD |  | -70 |  | dBc |
| Spurious-Free Dynamic Range | SFDR |  | 66 |  | dBc |
| Intermodulation Distortion | IMD | $\mathrm{f}_{\mathrm{IN} 1}=9.9 \mathrm{kHz}, \mathrm{fiN2}=10.2 \mathrm{kHz}$ | 72 |  | dBc |
| Full-Linear Bandwidth |  | SINAD > 70dB | 100 |  | kHz |
| Full-Power Bandwidth |  | -3dB point | 1 |  | MHz |
| CONVERSION RATE (Note 3) |  |  |  |  |  |
|  |  | External reference | 0.8 |  | $\mu \mathrm{s}$ |
| Power-Up Time | tPu | Internal reference (Note 4) | 218 |  | Conversion clock cycles |

## 10-Bit, Multichannel ADCs/DACs with FIFO, Temperature Sensing, and GPIO Ports

## ELECTRICAL CHARACTERISTICS (continued)

$\left(A V_{D D}=D V_{D D}=2.7 \mathrm{~V}\right.$ to $3.6 \mathrm{~V}(\mathrm{MAX1041} / \mathrm{MAX1043} / \mathrm{MAX1047/MAX1049})$, external reference $\mathrm{V}_{\mathrm{REF}}=2.5 \mathrm{~V}(\mathrm{MAX1041} / \mathrm{MAX1043} /$ MAX1047/MAX1049), $A V_{D D}=D V_{D D}=4.75 V$ to $5.25 \mathrm{~V}(M A X 1040 / M A X 1042 / M A X 1046 / M A X 1048)$, external reference $V_{\text {REF }}=4.096 \mathrm{~V}$ (MAX1040/MAX1042/MAX1046/MAX1048), fsCLK $=4.8 \mathrm{MHz}\left(50 \%\right.$ duty cycle), $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$, unless otherwise noted. Typical values are at $A V_{D D}=D V_{D D}=3 V(M A X 1041 / M A X 1043 / M A X 1047 / M A X 1049), A V_{D D}=D V_{D D}=5 V(M A X 1040 / M A X 1042 /$ MAX1046/MAX1048), $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$. Outputs are unloaded, unless otherwise noted.)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Acquisition Time | tACQ | (Note 5) | 0.6 |  |  | $\mu \mathrm{s}$ |
| Conversion Time | tconv | Internally clocked | 3.5 |  |  | $\mu \mathrm{S}$ |
|  |  | Externally clocked | 2.7 |  |  |  |
| Internal Clock Frequency |  | Internally clocked conversion | 4.3 |  |  | MHz |
| External Clock Frequency | fCLK | Externally clocked conversion (Note 5) | 0.1 |  | 4.8 | MHz |
| Duty Cycle |  |  | 40 |  | 60 | \% |
| Aperture Delay |  |  |  | 30 |  | ns |
| Aperture Jitter |  |  |  | <50 |  | ps |
| ANALOG INPUTS |  |  |  |  |  |  |
| Input Voltage Range (Note 6) |  | Unipolar | 0 |  | VREF | V |
|  |  | Bipolar | - $\mathrm{V}_{\text {REF }} / 2$ |  | $\mathrm{V}_{\text {REF }} / 2$ |  |
| Input Leakage Current |  |  |  | $\pm 0.01$ | $\pm 1$ | $\mu \mathrm{A}$ |
| Input Capacitance |  |  |  | 24 |  | pF |
| INTERNAL TEMPERATURE SENSOR |  |  |  |  |  |  |
| Measurement Error (Notes 5, 7) |  | $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ |  | $\pm 0.7$ |  | ${ }^{\circ} \mathrm{C}$ |
|  |  | $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ |  | $\pm 1.0$ | $\pm 3.0$ |  |
| Temperature Resolution |  |  |  | 1/8 |  | ${ }^{\circ} \mathrm{C} / \mathrm{LSB}$ |
| INTERNAL REFERENCE |  |  |  |  |  |  |
| REF1 Output Voltage |  | MAX1041/MAX1043/MAX1047/MAX1049 | 2.482 | 2.50 | 2.518 | V |
|  |  | MAX1040/MAX1042/MAX1046/MAX1048 | 4.066 | 4.096 | 4.126 |  |
| REF1 Voltage Temperature Coefficient | TCREF |  |  | $\pm 30$ |  | $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ |
| REF1 Output Impedance |  |  |  | 6.5 |  | $\mathrm{k} \Omega$ |
| REF1 Short-Circuit Current |  | $V_{\text {REF }}=2.5 \mathrm{~V}$ (MAX1041/MAX1043/ MAX1047/MAX1049) |  | 0.39 |  | mA |
|  |  | $\begin{aligned} & \text { VREF }=4.096 \mathrm{~V} \text { (MAX1040/MAX1042/ } \\ & \text { MAX1046/MAX1048) } \end{aligned}$ |  | 0.63 |  |  |
| EXTERNAL REFERENCE |  |  |  |  |  |  |
| REF1 Input Voltage Range | VREF1 | REF mode 11 (Note 4) | 1 |  | $\begin{gathered} \mathrm{A} \mathrm{~V}_{\mathrm{DD}}+ \\ 0.05 \end{gathered}$ | V |
| REF2 Input Voltage Range (Note 4) | $V_{\text {REF2 }}$ | REF mode 01 | 1 |  | $\begin{gathered} \mathrm{A} \mathrm{~V}_{\mathrm{DD}}+ \\ 0.05 \end{gathered}$ | V |
|  |  | REF mode 11 | 0 |  | 1 |  |

# 10-Bit, Multichannel ADCs/DACs with FIFO, Temperature Sensing, and GPIO Ports 

## ELECTRICAL CHARACTERISTICS (continued)

$\left(A V_{D D}=D V_{D D}=2.7 \mathrm{~V}\right.$ to $3.6 \mathrm{~V}(\mathrm{MAX1041} / \mathrm{MAX1043} / \mathrm{MAX1047/MAX1049})$, external reference $\mathrm{V}_{\mathrm{REF}}=2.5 \mathrm{~V}$ (MAX1041/MAX1043/ MAX1047/MAX1049), $A V_{D D}=D V_{D D}=4.75 \mathrm{~V}$ to 5.25 V (MAX1040/MAX1042/MAX1046/MAX1048), external reference $\mathrm{V}_{\text {REF }}=4.096 \mathrm{~V}$ (MAX1040/MAX1042/MAX1046/MAX1048), fSCLK $=4.8 \mathrm{MHz}\left(50 \%\right.$ duty cycle), $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$, unless otherwise noted. Typical values are at $A V_{D D}=D V_{D D}=3 V(M A X 1041 / M A X 1043 / M A X 1047 / M A X 1049), A V_{D D}=D V_{D D}=5 V(M A X 1040 / M A X 1042 /$ MAX1046/MAX1048), $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$. Outputs are unloaded, unless otherwise noted.)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| REF1 Input Current (Note 9) | IREF1 | $V_{\text {REF }}=2.5 \mathrm{~V}$ (MAX1041/MAX1043/ MAX1047/MAX1049), fSAMPLE $=300 \mathrm{ksps}$ |  | 25 | 80 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\text {REF }}=4.096 \mathrm{~V}$ (MAX1040/MAX1042/ MAX1046/MAX1048), fSAMPLE $=300 \mathrm{ksps}$ |  | 40 | 80 |  |
|  |  | Acquisition between conversions |  | $\pm 0.01$ | $\pm 1$ |  |
| REF2 Input Current | IREF2 | $V_{\text {REF }}=2.5 \mathrm{~V}$ (MAX1041/MAX1043/ MAX1047/MAX1049), fSAMPLE $=300 \mathrm{ksps}$ |  | 25 | 80 | $\mu \mathrm{A}$ |
|  |  | $\begin{array}{\|l\|} \hline \text { VREF }=4.096 V(\text { MAX1040/MAX1042/ } \\ \text { MAX1046/MAX1048), fSAMPLE }=300 \mathrm{ksps} \\ \hline \end{array}$ |  | 40 | 80 |  |
|  |  | Acquisition between conversions |  | $\pm 0.01$ | $\pm 1$ |  |

## DC ACCURACY (Note 10)

| Resolution |  |  | 10 |  | Bits |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Integral Nonlinearity | INL |  | $\pm 0.5$ | $\pm 1$ | LSB |
| Differential Nonlinearity | DNL | Guaranteed monotonic |  | $\pm 0.5$ | LSB |
| Offset Error | Vos |  | $\pm 3$ | $\pm 10$ | mV |
| Offset-Error Drift |  |  | $\pm 10$ |  | ppm of FS $/{ }^{\circ} \mathrm{C}$ |
| Gain Error | GE |  | $\pm 1.25$ | $\pm 10$ | LSB |
| Gain Temperature Coefficient |  |  | $\pm 8$ |  | ppm of FS/ $/{ }^{\circ} \mathrm{C}$ |

## DAC OUTPUT

| Output Voltage Range |  | No load | 0.02 | $\begin{gathered} A V_{D D}- \\ 0.02 \end{gathered}$ | V |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | $10 \mathrm{k} \Omega$ load to either rail | 0.1 | $\begin{gathered} A V_{D D}- \\ 0.1 \end{gathered}$ |  |
| DC Output Impedance |  |  |  |  | $\Omega$ |
| Capacitive Load |  | (Note 11) |  | 1 | nF |
| Resistive Load to AGND | RL | $\mathrm{A}_{\mathrm{DD}}=2.7 \mathrm{~V}, \mathrm{~V}_{\mathrm{REF}}=2.5 \mathrm{~V}(\mathrm{MAX1041} /$ MAX1043/MAX1047/MAX1049), gain error < $1 \%$ | 2000 |  | $\Omega$ |
|  |  | $\mathrm{AV}_{\mathrm{DD}}=4.75 \mathrm{~V}, \mathrm{~V}_{\mathrm{REF}}=4.096 \mathrm{~V}$ (MAX1040/ MAX1042/MAX1046/MAX1048), <br> gain error < 2\% | 500 |  |  |

## 10-Bit, Multichannel ADCs/DACs with FIFO, Temperature Sensing, and GPIO Ports

## ELECTRICAL CHARACTERISTICS (continued)

$\left(A V_{D D}=D V_{D D}=2.7 \mathrm{~V}\right.$ to $3.6 \mathrm{~V}(\mathrm{MAX1041} / \mathrm{MAX1043} / \mathrm{MAX1047/MAX1049})$, external reference $\mathrm{V}_{\mathrm{REF}}=2.5 \mathrm{~V}(\mathrm{MAX1041} / \mathrm{MAX1043} /$ MAX1047/MAX1049), $A V_{D D}=D V_{D D}=4.75 V$ to $5.25 \mathrm{~V}(M A X 1040 / M A X 1042 / M A X 1046 / M A X 1048)$, external reference $V_{\text {REF }}=4.096 \mathrm{~V}$ (MAX1040/MAX1042/MAX1046/MAX1048), fSCLK $=4.8 \mathrm{MHz}$ ( $50 \%$ duty cycle), $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$, unless otherwise noted. Typical values are at $A V_{D D}=D V_{D D}=3 V(M A X 1041 / M A X 1043 / M A X 1047 / M A X 1049), A V_{D D}=D V_{D D}=5 V(M A X 1040 / M A X 1042 /$ MAX1046/MAX1048), $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$. Outputs are unloaded, unless otherwise noted.)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Wake-Up Time (Note 12) |  | From power-down mode, AV DD $=5 \mathrm{~V}$ |  | 25 |  | $\mu \mathrm{s}$ |
|  |  | From power-down mode, $\mathrm{AV} \mathrm{V}_{\mathrm{DD}}=2.7 \mathrm{~V}$ |  | 21 |  |  |
| $1 \mathrm{k} \Omega$ Output Termination |  | Programmed in power-down mode |  | 1 |  | k $\Omega$ |
| $100 \mathrm{k} \Omega$ Output Termination |  | At wake-up or programmed in power-down mode |  | 100 |  | $\mathrm{k} \Omega$ |
| DYNAMIC PERFORMANCE (Notes 5, 13) |  |  |  |  |  |  |
| Output-Voltage Slew Rate | SR | Positive and negative | 3 |  |  | V/us |
| Output-Voltage Settling Time | ts | To 1 LSB, 400 - C00 hex (Note 7) |  | 2 | 5 | $\mu \mathrm{s}$ |
| Digital Feedthrough |  | Code 0, all digital inputs from 0 to DVDD |  | 0.5 |  | $\mathrm{nV} \cdot \mathrm{s}$ |
| Major Code Transition Glitch Impulse |  | Between codes 2047 and 2048 |  | 4 |  | nV .s |
| Output Noise ( 0.1 Hz to 50 MHz ) |  | From VREF |  | 660 |  | $\mu \mathrm{V}_{\text {P-P }}$ |
|  |  | Using internal reference |  | 720 |  |  |
| Output Noise (0.1Hz to 500 kHz ) |  | From VREF |  | 260 |  | $\mu \mathrm{V}_{\mathrm{P} \text { - }}$ |
|  |  | Using internal reference |  | 320 |  |  |
| DAC-to-DAC Transition Crosstalk |  |  |  | 0.5 |  | nV .s |
| INTERNAL REFERENCE |  |  |  |  |  |  |
| REF1 Output Voltage |  | MAX1041/MAX1043/MAX1047/MAX1049 | 2.482 | 2.50 | 2.518 | V |
|  |  | MAX1040/MAX1042/MAX1046/MAX1048 | 4.066 | 4.096 | 4.126 |  |
| REF1 Temperature Coefficient | TCREF |  |  | $\pm 30$ |  | ppm $/{ }^{\circ} \mathrm{C}$ |
| REF1 Short-Circuit Current |  | $V_{\text {REF }}=2.5 \mathrm{~V}$ (MAX1041/MAX1043/ MAX1047/MAX1049) |  | 0.39 |  | mA |
|  |  | $V_{\text {REF }}=4.096 \mathrm{~V}$ (MAX1040/MAX1042/ MAX1046/MAX1048) |  | 0.63 |  |  |


| REF1 Input Voltage Range | V REF1 | REF modes 01, 10, and 11 (Note 4) | 0.7 | AV DD | V |  |
| :--- | :---: | :--- | :--- | :--- | :---: | :---: |
| REF1 Input Impedance | RREF1 |  | 70 | 100 | 130 | $\mathrm{k} \Omega$ |

DIGITAL INTERFACE
DIGITAL INPUTS (SCLK, DIN, $\overline{\mathbf{C S}}, \overline{\mathrm{CNVST}}, \overline{\mathrm{LDAC}})$

| Input-Voltage High | $\mathrm{V}_{\mathrm{IH}}$ | DV $\mathrm{DD}=2.7 \mathrm{~V}$ to 5.25 V | 2.4 |  | V |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | DV ${ }_{\text {DD }}=3.6 \mathrm{~V}$ to 5.25 V | 2.0 |  |  |
| Input-Voltage Low | VIL | DV ${ }_{\text {D }}=2.7 \mathrm{~V}$ to 3.6 V |  | 0.8 | V |
|  |  | DV $\mathrm{DD}=3 \mathrm{~V}$ to 3.6 V |  | 0.6 |  |
|  |  | DV $\mathrm{DD}=2.7 \mathrm{~V}$ to 3 V |  | 0.5 |  |
| Input Leakage Current | IL |  | 0.01 | $\pm 10$ | $\mu \mathrm{A}$ |

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## ELECTRICAL CHARACTERISTICS (continued)

$\left(A V_{D D}=D V_{D D}=2.7 \mathrm{~V}\right.$ to $3.6 \mathrm{~V}(\mathrm{MAX1041} / \mathrm{MAX1043} / \mathrm{MAX1047} / \mathrm{MAX1049})$, external reference $\mathrm{V}_{\mathrm{REF}}=2.5 \mathrm{~V}$ (MAX1041/MAX1043/ MAX1047/MAX1049), $A V_{D D}=D V_{D D}=4.75 \mathrm{~V}$ to 5.25 V (MAX1040/MAX1042/MAX1046/MAX1048), external reference $\mathrm{V}_{\text {REF }}=4.096 \mathrm{~V}$ (MAX1040/MAX1042/MAX1046/MAX1048), $\mathrm{fSCLK}=4.8 \mathrm{MHz}\left(50 \%\right.$ duty cycle), $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$, unless otherwise noted. Typical values are at $A V_{D D}=D V_{D D}=3 V(M A X 1041 / M A X 1043 / M A X 1047 / M A X 1049), A V_{D D}=D V_{D D}=5 V(M A X 1040 / M A X 1042 /$ MAX1046/MAX1048), $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$. Outputs are unloaded, unless otherwise noted.)


## 10-Bit, Multichannel ADCs/DACs with FIFO, Temperature Sensing, and GPIO Ports

## ELECTRICAL CHARACTERISTICS (continued)

$\left(A V_{D D}=D V_{D D}=2.7 \mathrm{~V}\right.$ to $3.6 \mathrm{~V}\left(\mathrm{MAX1041/MAX1043/MAX1047/MAX1049)}\right.$, external reference $\mathrm{V}_{\mathrm{REF}}=2.5 \mathrm{~V}$ (MAX1041/MAX1043/ MAX1047/MAX1049), $A V_{D D}=D V_{D D}=4.75 \mathrm{~V}$ to 5.25 V (MAX1040/MAX1042/MAX1046/MAX1048), external reference $\mathrm{V}_{\text {REF }}=4.096 \mathrm{~V}$ (MAX1040/MAX1042/MAX1046/MAX1048), ISCLK $^{2}=4.8 \mathrm{MHz}\left(50 \%\right.$ duty cycle), $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$, unless otherwise noted. Typical values are at $A V_{D D}=D V_{D D}=3 V(M A X 1041 / M A X 1043 / M A X 1047 / M A X 1049), A V_{D D}=D V_{D D}=5 V(M A X 1040 / M A X 1042 /$ MAX1046/MAX1048), $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$. Outputs are unloaded, unless otherwise noted.)

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# 10-Bit, Multichannel ADCs/DACs with FIFO, Temperature Sensing, and GPIO Ports 

## ELECTRICAL CHARACTERISTICS (continued)

$\left(A V_{D D}=D V_{D D}=2.7 \mathrm{~V}\right.$ to $3.6 \mathrm{~V}(M A X 1041 / \mathrm{MAX1043} / \mathrm{MAX1047} / \mathrm{MAX1049})$, external reference $\mathrm{V}_{\mathrm{REF}}=2.5 \mathrm{~V}(\mathrm{MAX1041} / \mathrm{MAX1043} /$ MAX1047/MAX1049), $A V_{D D}=D V_{D D}=4.75 V$ to 5.25V (MAX1040/MAX1042/MAX1046/MAX1048), external reference $V_{\text {REF }}=4.096 \mathrm{~V}$ (MAX1040/MAX1042/MAX1046/MAX1048), fSCLK $=4.8 \mathrm{MHz}\left(50 \%\right.$ duty cycle), $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$, unless otherwise noted. Typical values are at $A V_{D D}=D V_{D D}=3 V(M A X 1041 / M A X 1043 / M A X 1047 / M A X 1049), A V_{D D}=D V_{D D}=5 V(M A X 1040 / M A X 1042 /$ MAX1046/MAX1048), $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$. Outputs are unloaded, unless otherwise noted.)

| PARAMETER | SYMBOL | CONDITIONS | MIN $\quad$ TYP $\quad$ MAX | UNITS |
| :--- | :---: | :--- | :--- | :---: |
| CNVST Pulse Width | tcSw | CKSEL $=00$, CKSEL $=01$ (temp sense) | 40 | ns |
|  |  | CKSEL $=01$ (voltage conversion) | 1.4 | $\mu \mathrm{~s}$ |

Note 1: Tested at $D V_{D D}=A V_{D D}=3.6 \mathrm{~V}(M A X 1041 / M A X 1043 / M A X 1047 / M A X 1049), D V_{D D}=A V_{D D}=5.25 \mathrm{~V}(M A X 1040 / M A X 1042 /$ MAX1046/MAX1048)
Note 2: Offset nulled.
Note 3: No bus activity during conversion. Conversion time is defined as the number of conversion clock cycles multiplied by the clock period
Note 4: See Table 5 for reference-mode details.
Note 5: Not production tested. Guaranteed by design.
Note 6: See the ADC/DAC References section.
Note 7: Fast automated test, excludes self-heating effects.
Note 8: Specified over the $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ temperature range.
Note 9: REFSEL[1:0] = 00 or when DACs are not powered up.
Note 10: DAC linearity, gain, and offset measurements are made between codes 115 and 3981.
Note 11: The DAC buffers are guaranteed by design to be stable with a 1 nF load.
Note 12: Time required by the DAC output to power up and settle within 1 LSB in the external reference mode.
Note 13: All DAC dynamic specifications are valid for a load of 100 pF and $10 \mathrm{k} \Omega$.
Note 14: Only one digital output (either DOUT, $\overline{E O C}$, or the GPIOs) can be indefinitely shorted to either supply at one time.
Note 15: All digital inputs at either DVDD or DGND. DV ${ }_{D D}$ should not exceed AVDD.
Note 16: See the Reset Register section and Table 9 for details on programming the SLOW bit.
Note 17: Clock mode 11 only.
$\left(A V_{D D}=D V_{D D}=3 V(M A X 1041 / M A X 1043 / M A X 1047 / M A X 1049)\right.$, external $V_{R E F}=2.5 V(M A X 1041 / M A X 1043 / M A X 1047 / M A X 1049)$, $A V_{D D}=D V_{D D}=5 V(M A X 1040 / M A X 1042 / M A X 1046 / M A X 1048)$, external $V_{R E F}=4.096 V(M A X 1040 / M A X 1042 / M A X 1046 / M A X 1048)$,
$\mathrm{f}_{\mathrm{LL}}=4.8 \mathrm{MHz}\left(50 \%\right.$ duty cycle), fSAMPLE $=300 \mathrm{ksps}$, CLOAD $=50 \mathrm{pF}, 0.1 \mu \mathrm{~F}$ capacitor at REF, $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.)


## 10-Bit, Multichannel ADCs/DACs with FIFO, Temperature Sensing, and GPIO Ports

## Typical Operating Characteristics (continued)

$\left(A V_{D D}=D V_{D D}=3 V(M A X 1041 / M A X 1043 / M A X 1047 / M A X 1049)\right.$, external $V_{R E F}=2.5 V(M A X 1041 / M A X 1043 / M A X 1047 / M A X 1049)$, $A V_{D D}=D V_{D D}=5 V(M A X 1040 / M A X 1042 / M A X 1046 / M A X 1048)$, external $V_{R E F}=4.096 V$ (MAX1040/MAX1042/MAX1046/MAX1048), f CLK $=4.8 \mathrm{MHz}\left(50 \%\right.$ duty cycle), $\mathrm{fSAMPLE}=300 \mathrm{ksps}, \mathrm{CLOAD}=50 \mathrm{pF}, 0.1 \mu \mathrm{~F}$ capacitor at REF, $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.)


## 10-Bit, Multichannel ADCs/DACs with FIFO, Temperature Sensing, and GPIO Ports

## Typical Operating Characteristics (continued)

$\left(A V_{D D}=D V_{D D}=3 V(M A X 1041 / M A X 1043 / M A X 1047 / M A X 1049)\right.$, external $V_{R E F}=2.5 V(M A X 1041 / M A X 1043 / M A X 1047 / M A X 1049)$, $A V_{D D}=D V_{D D}=5 V(M A X 1040 / M A X 1042 / M A X 1046 / M A X 1048)$, external $V_{R E F}=4.096 \mathrm{~V}$ (MAX1040/MAX1042/MAX1046/MAX1048), $\mathrm{fCLK}=4.8 \mathrm{MHz}\left(50 \%\right.$ duty cycle), $\mathrm{fSAMPLE}=300 \mathrm{ksps}, \mathrm{CLOAD}=50 \mathrm{pF}, 0.1 \mu \mathrm{~F}$ capacitor at REF, $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.)


## 10－Bit，Multichannel ADCs／DACs with FIFO， Temperature Sensing，and GPIO Ports

Typical Operating Characteristics（continued）
$\left(A V_{D D}=D V_{D D}=3 V(M A X 1041 / M A X 1043 / M A X 1047 / M A X 1049)\right.$ ，external $V_{R E F}=2.5 V$（MAX1041／MAX1043／MAX1047／MAX1049）， $A V_{D D}=D V_{D D}=5 V(M A X 1040 / M A X 1042 / M A X 1046 / M A X 1048)$ ，external $V_{R E F}=4.096 V$（MAX1040／MAX1042／MAX1046／MAX1048）， $\mathrm{f}_{\mathrm{CLK}}=4.8 \mathrm{MHz}\left(50 \%\right.$ duty cycle）， $\mathrm{fSAMPLE}=300 \mathrm{ksps}, \mathrm{CLOAD}=50 \mathrm{pF}, 0.1 \mu \mathrm{~F}$ capacitor at REF， $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ ，unless otherwise noted．）


## 10-Bit, Multichannel ADCs/DACs with FIFO, Temperature Sensing, and GPIO Ports

$\left(A V_{D D}=D V_{D D}=3 V(M A X 1041 / M A X 1043 / M A X 1047 / M A X 1049)\right.$, external $V_{R E F}=2.5 V$ (MAX1041/MAX1043/MAX1047/MAX1049), $A V_{D D}=D V_{D D}=5 V(M A X 1040 / M A X 1042 / M A X 1046 / M A X 1048)$, external $V_{R E F}=4.096 \mathrm{~V}$ (MAX1040/MAX1042/MAX1046/MAX1048), $\mathrm{fCLK}=4.8 \mathrm{MHz}\left(50 \%\right.$ duty cycle), $\mathrm{fSAMPLE}=300 \mathrm{ksps}, \mathrm{CLOAD}=50 \mathrm{pF}, 0.1 \mu \mathrm{~F}$ capacitor at REF, $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.)


ADC REFERENCE SUPPLY CURRENT vs. ANALOGSUPPLY VOLTAGE


DACFUL-SCALE 日ROR
vs. REPRENCE VOLTACE


INIERNAL REERENCE VOLTACE vs. TEMPERATURE


ADCREPRENCESUPPLY CURRENT vs. ANALOGSUPPLY VOLTAGE


DACFUL-SCALE EROR vs. LOAD CURRENT


INIERNAL REPRENCE VOLTACE vs. TEMPERATURE


ADCREPERENCE SUPPLY CURRENT vs. TEMPERATURE


## 10-Bit, Multichannel ADCs/DACs with FIFO, Temperature Sensing, and GPIO Ports

Typical Operating Characteristics (continued)
$\left(A V_{D D}=D V_{D D}=3 V(M A X 1041 / M A X 1043 / M A X 1047 / M A X 1049)\right.$, external $V_{R E F}=2.5 V$ (MAX1041/MAX1043/MAX1047/MAX1049), $A V_{D D}=D V_{D D}=5 V(M A X 1040 / M A X 1042 / M A X 1046 / M A X 1048)$, external $V_{R E F}=4.096 V(M A X 1040 / M A X 1042 / M A X 1046 / M A X 1048)$, $\mathrm{f}_{\mathrm{CLK}}=4.8 \mathrm{MHz}\left(50 \%\right.$ duty cycle), $\mathrm{fSAMPLE}=300 \mathrm{ksps}, \mathrm{CLOAD}=50 \mathrm{pF}, 0.1 \mu \mathrm{~F}$ capacitor at REF, $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.)


## 10-Bit, Multichannel ADCs/DACs with FIFO, Temperature Sensing, and GPIO Ports

## Typical Operating Characteristics (continued)

$\left(A V_{D D}=D V_{D D}=3 V(M A X 1041 / M A X 1043 / M A X 1047 / M A X 1049)\right.$, external $V_{R E F}=2.5 V(M A X 1041 / M A X 1043 / M A X 1047 / M A X 1049)$, $A V_{D D}=D V_{D D}=5 V(M A X 1040 / M A X 1042 / M A X 1046 / M A X 1048)$, external $V_{R E F}=4.096 \mathrm{~V}$ (MAX1040/MAX1042/MAX1046/MAX1048), $\mathrm{fCLK}=4.8 \mathrm{MHz}\left(50 \%\right.$ duty cycle), $\mathrm{fSAMPLE}=300 \mathrm{ksps}, \mathrm{CLOAD}=50 \mathrm{pF}, 0.1 \mu \mathrm{~F}$ capacitor at REF, $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.)


## 10-Bit, Multichannel ADCs/DACs with FIFO, Temperature Sensing, and GPIO Ports

## Typical Operating Characteristics (continued)

$\left(A V_{D D}=D V_{D D}=3 V(M A X 1041 / M A X 1043 / M A X 1047 / M A X 1049)\right.$, external $V_{R E F}=2.5 V(M A X 1041 / M A X 1043 / M A X 1047 / M A X 1049)$, $A V_{D D}=D V_{D D}=5 V(M A X 1040 / M A X 1042 / M A X 1046 / M A X 1048)$, external $V_{R E F}=4.096 V(M A X 1040 / M A X 1042 / M A X 1046 / M A X 1048)$, $\mathrm{f}_{\mathrm{CLK}}=4.8 \mathrm{MHz}\left(50 \%\right.$ duty cycle), $\mathrm{fSAMPLE}=300 \mathrm{ksps}, \mathrm{CLOAD}=50 \mathrm{pF}, 0.1 \mu \mathrm{~F}$ capacitor at REF, $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.)


## 10-Bit, Multichannel ADCs/DACs with FIFO, Temperature Sensing, and GPIO Ports

Pin Description

| $\begin{aligned} & \text { MAX1040 } \\ & \text { MAX1041 } \end{aligned}$ | $\begin{aligned} & \text { MAX1042 } \\ & \text { MAX1043 } \end{aligned}$ | MAX1046 MAX1047 | $\begin{aligned} & \text { MAX1048 } \\ & \text { MAX1049 } \end{aligned}$ | NAME | FUNCTION |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\begin{gathered} 1,2,15-19, \\ 23,24,25, \\ 32,33 \end{gathered}$ | $\begin{gathered} 15-19,23, \\ 32,33 \end{gathered}$ | $\begin{gathered} 1,2,15-19, \\ 23,24,25, \\ 31-34 \end{gathered}$ | $\begin{gathered} 15-19,23 \\ 31-34 \end{gathered}$ | N.C. | No Connection. Not internally connected. |
| 3 | 3 | 3 | 3 | EOC | Active-Low End-of-Conversion Output. Data is valid after the falling edge of $\overline{E O C}$. |
| 4 | 4 | 4 | 4 | DVDD | Digital Positive Power Input. Bypass DVDD to DGND with a $0.1 \mu \mathrm{~F}$ capacitor. |
| 5 | 5 | 5 | 5 | DGND | Digital Ground. Connect DGND to AGND. |
| 6 | 6 | 6 | 6 | DOUT | Serial Data Output. Data is clocked out on the falling edge of the SCLK clock in clock modes 00,01, and 10. Data is clocked out on the rising edge of the SCLK clock in clock mode 11. High impedance when $\overline{\mathrm{CS}}$ is high. |
| 7 | 7 | 7 | 7 | SCLK | Serial Clock Input. Clocks data in and out of the serial interface. (Duty cycle must be $40 \%$ to $60 \%$.) See Table 4 for details on programming the clock mode. |
| 8 | 8 | 8 | 8 | DIN | Serial Data Input. DIN data is latched into the serial interface on the falling edge of SCLK. |
| 9-12 | 9-12 | 9-12 | 9-12 | $\begin{aligned} & \text { OUT0- } \\ & \text { OUT3 } \end{aligned}$ | DAC Outputs |
| 13 | 13 | 13 | 13 | AV ${ }_{\text {DD }}$ | Positive Analog Power Input. Bypass AVDD to AGND with a $0.1 \mu \mathrm{~F}$ capacitor. |
| 14 | 14 | 14 | 14 | AGND | Analog Ground |
| 20 | 20 | 20 | 20 | $\overline{\text { LDAC }}$ | Active-Low Load DAC. $\overline{\text { LDAC }}$ is an asynchronous active-low input that updates the DAC outputs. Drive $\overline{\mathrm{LDAC}}$ low to make the DAC registers transparent. |
| 21 | 21 | 21 | 21 | $\overline{\mathrm{CS}}$ | Active-Low Chip-Select Input. When $\overline{\mathrm{CS}}$ is low, the serial interface is enabled. When $\overline{\mathrm{CS}}$ is high, DOUT is high impedance. |

## 10-Bit, Multichannel ADCs/DACs with FIFO, Temperature Sensing, and GPIO Ports

| Pin Description (continued) |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| MAX1040 MAX1041 | MAX1042 MAX1043 | $\begin{aligned} & \text { MAX1046 } \\ & \text { MAX1047 } \end{aligned}$ | MAX1048 MAX1049 | NAME | FUNCTION |
| 22 | 22 | 22 | 22 | RES_SEL | Reset Select. Selects DAC wake-up mode. Set RES_SEL low to wake up the DAC outputs with a $100 \mathrm{k} \Omega$ resistor to GND or set RES_SEL high to wake up the DAC outputs with a $100 \mathrm{k} \Omega$ resistor to VREF. Set RES_SEL high to power up the DAC input register to FFFh. Set RES_SEL low to power up the DAC input register to 000h. |
| 26 | 26 | 26 | 26 | REF1 | Reference 1 Input. Reference voltage. Leave unconnected to use the internal reference $(2.5 \mathrm{~V}$ for the MAX1041/MAX1043/MAX1047/MAX1049 or 4.096V for the MAX1040/MAX1042/MAX1046/MAX1048). REF1 is the positive reference in ADC external differential mode. Bypass REF1 to AGND with a $0.1 \mu \mathrm{~F}$ capacitor in external reference mode only. See the ADC/DAC References section. |
| 27-31, 34 | 27-31, 34 | - | - | AIN0-AIN5 | Analog Inputs |
| 35 | 35 | - | - | REF2/AIN6 | Reference 2 Input/Analog Input Channel 6. See Table 5 for details on programming the setup register. REF2 is the negative reference in the ADC external differential reference mode. |
| 36 | 36 | - | - | $\overline{\text { CNVST/ }}$ AIN7 | Active-Low Conversion Start Input/Analog Input 7. See Table 5 for details on programming the setup register. |
| - | 1, 2 | - | 1, 2 | GPIOAO, GPIOA1 | General-Purpose I/O A0, A1. GPIOA0, GPIOA1 can sink and source 15 mA . |
| - | 24, 25 | - | 24, 25 | GPIOCO, GPIOC1 | General-Purpose I/O C0, C1. GPIOC0, GPIOC1 can sink 4mA and source 2 mA . |
| - | - | 27-30 | 27-30 | AIN0-AIN3 | Analog Inputs |
| - | - | 35 | 35 | REF2 | Reference 2 Input. See Table 5 for details on programming the setup register. REF2 is the negative reference in the ADC external differential reference mode. |
| - | - | 36 | 36 | $\overline{\text { CNVST }}$ | Active-Low Conversion Start Input. See Table 5 details on programming the setup register. |
| - | - | - | - | EP | Exposed Paddle. Must be externally connected to AGND. Do not use as a ground connect. |

# 10-Bit, Multichannel ADCs/DACs with FIFO, Temperature Sensing, and GPIO Ports 



The MAX1040-MAX1043/MAX1046-MAX1049 integrate a multichannel 10-bit ADC and a quad 10-bit DAC in a single IC. These devices also include a temperature sensor and configurable GPIOs with a 25 MHz SPI-/QSPI-/MICROWIRE-compatible serial interface. The ADC is available in a 4 or an 8 input-channel version. The four DAC outputs settle within $2.0 \mu \mathrm{~s}$, and the ADC has a 300ksps conversion rate.
All devices include an internal reference ( 2.5 V or 4.096 V ) providing a well-regulated, low-noise reference for both the ADC and DAC. Programmable reference modes for the ADC and DAC allow the use of an internal reference, an external reference, or a combination of both. Features such as an internal $\pm 1^{\circ} \mathrm{C}$ accurate temperature sensor, FIFO, scan modes, programmable internal or external clock modes, data averaging, and AutoShutdown allow users to minimize both power consumption and processor requirements. The low glitch energy ( $4 \mathrm{nV} \cdot \mathrm{s}$ ) and low digital feedthrough $(0.5 \mathrm{nV} \cdot \mathrm{s}$ ) of the integrated quad DACs make these devices ideal for digital control of fast-response closed-loop systems.
The devices are guaranteed to operate with a supply voltage from +2.7 V to +3.6 V (MAX1041/MAX1043/ MAX1047/MAX1049) and from +4.5 V to +5.5 V (MAX1040/MAX1042/MAX1046/MAX1048). These devices consume 2.5 mA at 300 ksps throughput, only $0.22 \mu \mathrm{~A}$ at 1 ksps throughput, and under $0.2 \mu \mathrm{~A}$ in the shutdown mode. The MAX1042/MAX1043/MAX1048/ MAX1049 offer four GPIOs that can be configured as inputs or outputs.
Figure 1 shows the MAX1042/MAX1043 functional diagram. The MAX1042/MAX1043/MAX1048/MAX1049 only include the GPIO A0, A1, GPIO C0, C1 blocks. The MAX1040/MAX1041/MAX1046/MAX1047 exclude the GPIOs. The output-conditioning circuitry takes the internal parallel data bus and converts it to a serial data format at DOUT, with the appropriate wake-up timing. The arithmetic logic unit (ALU) performs the averaging function.

## SPI-Compatible Serial Interface

The MAX1040-MAX1043/MAX1046-MAX1049 feature a serial interface that is compatible with SPI and MICROWIRE devices. For SPI, ensure the SPI bus master (typically a microcontroller ( $\mu \mathrm{C})$ ) runs in master mode so that it generates the serial clock signal. Select the SCLK frequency of 25 MHz or less, and set the clock polarity (CPOL) and phase (CPHA) in the $\mu \mathrm{C}$ con-
trol registers to the same value. The MAX1040-MAX1043/MAX1046-MAX1049 operate with SCLK idling high or low, and thus operate with CPOL = CPHA $=0$ or CPOL $=\mathrm{CPHA}=1$. Set $\overline{\mathrm{CS}}$ low to latch any input data at DIN on the falling edge of SCLK. Output data at DOUT is updated on the falling edge of SCLK in clock modes 00, 01, and 10. Output data at DOUT is updated on the rising edge of SCLK in clock mode 11. See Figures 6-11. Bipolar true-differential results and tem-perature-sensor results are available in two's complement format, while all other results are in binary.
A high-to-low transition on $\overline{\mathrm{CS}}$ initiates the data-input operation. Serial communications to the ADC always begin with an 8-bit command byte (MSB first) loaded from DIN. The command byte and the subsequent data bytes are clocked from DIN into the serial interface on the falling edge of SCLK. The serial-interface and fastinterface circuitry is common to the ADC, DAC, and GPIO sections. The content of the command byte determines whether the SPI port should expect 8,16 , or 24 bits and whether the data is intended for the ADC, DAC, or GPIOs (if applicable). See Table 1. Driving $\overline{\mathrm{CS}}$ high resets the serial interface.
The conversion register controls ADC channel selection, ADC scan mode, and temperature-measurement requests. See Table 4 for information on writing to the conversion register. The setup register controls the clock mode, reference, and unipolar/bipolar ADC configuration. Use a second byte, following the first, to write to the unipolar-mode or bipolar-mode registers. See Table 5 for details of the setup register and see Tables 6, 7, and 8 for setting the unipolar- and bipolarmode registers. Hold $\overline{C S}$ low between the command byte and the second and third byte. The ADC averaging register is specific to the ADC. See Table 9 to address that register. Table 11 shows the details of the reset register.
Begin a write to the DAC by writing 0001XXXX as a command byte. The last 4 bits of this command byte are don't-care bits. Write another 2 bytes (holding CS low) to the DAC interface register following the command byte to select the appropriate DAC and the data to be written to it. See the DAC Serial Interface section and Tables 10, 17, and 18.
Write to the GPIOs (if applicable) by issuing a command byte to the appropriate register. Writing to the MAX1042/MAX1043/MAX1048/MAX1049 GPIOs requires 1 additional byte following the command byte.

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Figure 1．MAX1042／MAX1043 Functional Diagram

# 10-Bit, Multichannel ADCs/DACs with FIFO, Temperature Sensing, and GPIO Ports 

Table 1. Command Byte (MSB First)

| REGISTER NAME | BIT 7 | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Conversion* | 1 | X | CHSEL2 | CHSEL1 | CHSEL0 | SCAN1 | SCAN0 | TEMP |
| Setup | 0 | 1 | CKSEL1 | CKSEL0 | REFSEL1 | REFSEL0 | DIFFSEL1 | DIFFSEL0 |
| ADC Averaging | 0 | 0 | 1 | AVGON | NAVG1 | NAVG0 | NSCAN1 | NSCAN0 |
| DAC Select | 0 | 0 | 0 | 1 | X | X | X | X |
| Reset | 0 | 0 | 0 | 0 | 1 | RESET | SLOW | FBGON |
| GPIO Configure** | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 |
| GPIO Write** $^{\text {GPIO Read** }}$ | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| No Operation | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 |

$X=$ Don't care.
*CHESL2 bit is only valid on the MAX1040-MAX1043. Set CHSEL2 to 0 on the MAX1046-MAX1049.
**Only applicable on the MAX1042/MAX1043/MAX1048/MAX1049.

See Tables 12-16 for details on GPIO configuration, writes, and reads. See the GPIO Command section. Command bytes written to the GPIOs on devices without GPIOs are ignored.

## Power-Up Default State

The MAX1040-MAX1043/MAX1046-MAX1049 power up with all blocks in shutdown (including the reference). All registers power up in state 00000000 , except for the setup register and the DAC input register. The setup register powers up at 00101000 with CKSEL1 = 1 and REFSEL1 = 1 . The DAC input register powers up to FFFh when RES_SEL is high, and it powers up to 000h when RES_SEL is low.

10-Bit ADC
The MAX1040-MAX1043/MAX1046-MAX1049 ADCs use a fully differential successive-approximation register (SAR) conversion technique and on-chip track-andhold (T/H) circuitry to convert temperature and voltage signals into 10 -bit digital results. The analog inputs accept both single-ended and differential input signals. Single-ended signals are converted using a unipolar transfer function, and differential signals are converted using a selectable bipolar or unipolar transfer function. See the ADC Transfer Functions section for more data.

## ADC Clock Modes

When addressing the setup, register bits 5 and 4 of the command byte (CKSEL1 and CKSELO, respectively) control the ADC clock modes. See Table 5. Choose between four different clock modes for various ways to start a conversion and determine whether the acquisitions are internally or externally timed. Select clock mode 00 to configure CNVST/AIN_ to act as a conver-
sion start and use it to request internally timed conversions, without tying up the serial bus. In clock mode 01, use CNVST to request conversions one channel at a time, thereby controlling the sampling speed without tying up the serial bus. Request and start internally timed conversions through the serial interface by writing to the conversion register in the default clock mode, 10. Use clock mode 11 with SCLK up to 4.8 MHz for externally timed acquisitions to achieve sampling rates up to 300 ksps . Clock mode 11 disables scanning and averaging. See Figures 6-9 for timing specifications on how to begin a conversion.
These devices feature an active-low, end-of-conversion output. $\overline{E O C}$ goes low when the ADC completes the last requested operation and is waiting for the next command byte. EOC goes high when CS or CNVST go low. $\overline{\mathrm{EOC}}$ is always high in clock mode 11.

## Single-Ended or Differential Conversions

 The MAX1040-MAX1043/MAX1046-MAX1049 use a fully differential ADC for all conversions. When a pair of inputs are connected as a differential pair, each input is connected to the ADC. When configured in singleended mode, the positive input is the single-ended channel and the negative input is referred to AGND. See Figure 2.In differential mode, the T/H samples the difference between two analog inputs, eliminating common-mode DC offsets and noise. $\operatorname{IN}+$ and $I N$ - are selected from the following pairs: AIN0/AIN1, AIN2/AIN3, AIN4/AIN5, AIN6/AIN7. AIN0-AIN3 are available on all devices. AINO-AIN7 are available on the MAX1040-MAX1043. See Tables 5-8 for more details on configuring the

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inputs. For the inputs that are configurable as CNVST, REF2, and an analog input, only one function can be used at a time.

## Unipolar or Bipolar Conversions

Address the unipolar- and bipolar-mode registers through the setup register (bits 1 and 0 ). See Table 5 for the setup register. See Figures 3 and 4 for the transferfunction graphs. Program a pair of analog inputs for differential operation by writing a one to the appropriate bit of the bipolar- or unipolar-mode register. Unipolar mode sets the differential input range from 0 to $V_{\text {REF1. }}$ A negative differential analog input in unipolar mode causes the digital output code to be zero. Selecting bipolar mode sets the differential input range to $\pm \mathrm{V}_{\text {REF } 1} / 2$. The digital output code is binary in unipolar mode and two's complement in bipolar mode.
In single-ended mode, the MAX1040-MAX1043/ MAX1046-MAX1049 always operate in unipolar mode. The analog inputs are internally referenced to AGND with a full-scale input range from 0 to the selected reference voltage.

Analog Input (T/H)
The equivalent circuit of Figure 2 shows the ADC input architecture of the MAX1040-MAX1043/MAX1046MAX1049. In track mode, a positive input capacitor is connected to AIN0-AIN7 in single-ended mode and AIN0, AIN2, AIN4, and AIN6 in differential mode. A negative input capacitor is connected to AGND in single-ended mode or AIN1, AIN3, AIN5, and AIN7 in


Figure 2. Equivalent Input Circuit
differential mode. For external T/H timing, use clock mode 01. After the T/H enters hold mode, the difference between the sampled positive and negative input voltages is converted. The input capacitance charging rate determines the time required for the $\mathrm{T} / \mathrm{H}$ to acquire an input signal. If the input signal's source impedance is high, the required acquisition time lengthens.
Any source impedance below $300 \Omega$ does not significantly affect the ADC's AC performance. A high-impedance source can be accommodated either by lengthening $\mathrm{t}_{\mathrm{ACQ}}$ (only in clock mode 01) or by placing a $1 \mu \mathrm{~F}$ capacitor between the positive and negative analog inputs. The combination of the analog-input source impedance and the capacitance at the analog input creates an RC filter that limits the analog input bandwidth.

Input Bandwidth
The ADC's input-tracking circuitry has a 1 MHz smallsignal bandwidth, making it is possible to digitize highspeed transient events and measure periodic signals with bandwidths exceeding the ADC's sampling rate by using undersampling techniques. Anti-alias prefiltering of the input signals is necessary to avoid high-frequency signals aliasing into the frequency band of interest.

## Analog-Input Protection

Internal electrostatic-discharge (ESD) protection diodes clamp all analog inputs to AVDD and AGND, allowing the inputs to swing from (AGND - 0.3V) to (AVDD + 0.3 V ) without damage. However, for accurate conversions near full scale, the inputs must not exceed $A V_{D D}$ by more than 50 mV or be lower than AGND by 50 mV . If an analog input voltage exceeds the supplies, limit the input current to 2 mA .

Internal FIFO
The MAX1040-MAX1043/MAX1046-MAX1049 contain a first-in/first-out (FIFO) buffer that holds up to 16 ADC results plus one temperature result. The internal FIFO allows the ADC to process and store multiple internally clocked conversions and a temperature measurement without being serviced by the serial bus.
If the FIFO is filled and further conversions are requested without reading from the FIFO, the oldest ADC results are overwritten by the new ADC results. Each result contains 2 bytes, with the MSB preceded by four leading zeros. After each falling edge of $\overline{\mathrm{CS}}$, the oldest available pair of bytes of data is available at DOUT, MSB first. When the FIFO is empty, DOUT is zero.
The first 2 bytes of data read out after a temperature measurement always contain the 10-bit temperature result, preceded by four leading zeros, MSB first. The

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LSB is followed by 2 sub-bits. If another temperature measurement is performed before the first temperature result is read out, the old measurement is overwritten by the new result. Temperature results are in degrees Celsius (two's complement), at a resolution of 8 LSB per degree. See the Temperature Measurements section for details on converting the digital code to a temperature.

10-Bit DAC
In addition to the 10 -bit ADC, the MAX1040-MAX1043/ MAX1046-MAX1049 also include four voltage-output, 10-bit, monotonic DACs with less than 1 LSB integral nonlinearity error and less than 0.5 LSB differential nonlinearity error. Each DAC has a $2 \mu \mathrm{~s}$ settling time and ultra-low glitch energy ( $4 \mathrm{nV} \cdot \mathrm{s}$ ). The 10 -bit DAC code is unipolar binary with 1 LSB $=V_{\text {REF }} / 1024$.

DAC Digital Interface
Figure 1 shows the functional diagram of the MAX1042/ MAX1043. The shift register converts a serial 16-bit word to parallel data for each input register operating with a clock rate up to 25 MHz . The SPI-compatible digital interface to the shift register consists of $\overline{\mathrm{CS}}$, SCLK, DIN, and DOUT. Serial data at DIN is loaded on the falling edge of SCLK. Pull $\overline{C S}$ low to begin a write sequence. Begin a write to the DAC by writing 0001 XXXX as a command byte. The last 4 bits of the DAC select register are don't-care bits. See Table 10. Write another 2 bytes to the DAC interface register following the command byte to select the appropriate DAC and the data to be written to it. See Tables 17 and 18.
The four double-buffered DACs include an input and a DAC register. The input registers are directly connected to the shift register and hold the result of the most recent write operation. The four 10-bit DAC registers hold the current output code for the respective DAC. Data can be transferred from the input registers to the DAC registers by pulling LDAC low or by writing the appropriate DAC command sequence at DIN. See Table 17. The outputs of the DACs are buffered through four rail-to-rail op amps.
The MAX1040-MAX1043/MAX1046-MAX1049 DAC output-voltage range is based on the internal reference or an external reference. Write to the setup register (see Table 5) to program the reference. If using an external voltage reference, bypass REF1 with a $0.1 \mu \mathrm{~F}$ capacitor to AGND. The MAX1041/MAX1043/MAX1047/

MAX1049 internal reference is 2.5 V . The MAX1040/ MAX1042/MAX1046/MAX1048 internal reference is 4.096 V . When using an external reference on any of these devices, the voltage range is 0.7 V to AV DD.

DAC Transfer Function See Table 2 for various analog outputs from the DAC.

## DAC Power-On Wake-Up Modes

The state of the RES_SEL input determines the wake-up state of the DAC outputs. Connect RES_SEL to AVDD or AGND upon power-up to be sure the DAC outputs wake up to a known state. Connect RES_SEL to AGND to wake up all DAC outputs at 000h. While RES_SEL is low, the $100 \mathrm{k} \Omega$ internal resistor pulls the DAC outputs to AGND and the output buffers are powered down. Connect RES_SEL to AVDD to wake up all DAC outputs at FFFh. While RES_SEL is high, the $100 \mathrm{k} \Omega$ pullup resistor pulls the DAC outputs to VREF1 and the output buffers are powered down.

DAC Power-Up Modes
See Table 18 for a description of the DAC power-up and power-down modes.

GPIOs
In addition to the internal ADC and DAC, the MAX1042/MAX1043/MAX1048/MAX1049 also provide four GPIO channels, GPIOAO, GPIOA1, GPIOC0, and GPIOC1.

Table 2. DAC Output Code Table

| DAC CONTENTS |  |  | ANALOG OUTPUT |
| :---: | :---: | :---: | :---: |
| MSB |  | LSB |  |
| 11 | 1111 | 1111 | $+\mathrm{V}_{\mathrm{REF}}\left(\frac{1023}{1024}\right)$ |
| 10 | 0000 | 0001 | $+\mathrm{V}_{\text {REF }}\left(\frac{1023}{1024}\right)$ |
| 10 | 0000 | 0000 | $+\mathrm{V}_{\text {REF }}\left(\frac{512}{1024}\right)=\left(\frac{+\mathrm{V}_{\text {REF }}}{2}\right)$ |
| 01 | 0111 | 0111 | $+\mathrm{V}_{\text {REF }}\left(\frac{511}{1024}\right)$ |
| 00 | 0000 | 0001 | $+\mathrm{V}_{\text {REF }}\left(\frac{1}{1024}\right)$ |
| 00 | 0000 | 0000 | 0 |

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Read and write to the GPIOs as detailed in Table 1 and Tables 12-16. Also, see the GPIO Command section. See Figures 11 and 12 for GPIO timing.
Write to the GPIOs by writing a command byte to the GPIO command register. Write a single data byte to the MAX1042/MAX1043/MAX1048/MAX1049 following the command byte.
The GPIOs can sink and source current. The MAX1042/MAX1043/MAX1048/MAX1049 GPIOAO and GPIOA1 can sink and source up to 15 mA . GPIOC0 and GPIOC1 can sink 4 mA and source 2 mA . See Table 3.

## Clock Modes <br> Internal Clock

The MAX1040-MAX1043/MAX1046-MAX1049 can operate from an internal oscillator. The internal oscillator is active in clock modes 00, 01, and 10. Figures 6 , 7, and 8 show how to start an ADC conversion in the three internally timed conversion modes.
Read out the data at clock speeds up to 25 MHz through the SPI interface.

External Clock
Set CKSEL1 and CKSELO in the setup register to 11 to set up the interface for external clock mode 11. See Table 5. Pulse SCLK at speeds from 0.1 MHz to 4.8 MHz . Write to SCLK with a $40 \%$ to $60 \%$ duty cycle. The SCLK frequency controls the conversion timing. See Figure 9 for clock mode 11 timing. See the ADC Conversions in Clock Mode 11 section.

## ADC/DAC References

Address the reference through the setup register, bits 3 and 2. See Table 5 . Following a wake-up delay, set $\operatorname{REFSEL}[1: 0]=00$ to program both the ADC and DAC for internal reference use. Set REFSEL[1:0] = 10 to program the ADC for internal reference. Set REFSEL[1:0] = 10 to program the DAC for external reference, REF1. When using REF1 or REF2/AIN_ in external reference mode, connect a $0.1 \mu \mathrm{~F}$ capacitor to AGND. Set $\operatorname{REFSEL}[1: 0]=01$ to program the ADC and DAC for

## Table 3. GPIO Maximum Sink/Source Current

| CURRENT | MAX1042/MAX1043/ <br> MAX1048/MAX1049 |  |
| :---: | :---: | :---: |
|  | GPIOA0, GPIOA1 | GPIOC0, GPIOC1 |
| SINK CURRENT | 15 mA | 4 mA |
| SOURCE CURRENT | 15 mA | 2 mA |

external reference mode. The DAC uses REF1 as its external reference, while the ADC uses REF2 as its external reference. Set REFSEL[1:0] = 11 to program the ADC for external differential-reference mode. REF1 is the positive reference and REF2 is the negative reference in the ADC external differential mode.
When REFSEL[1:0] = 00 or 10 , REF2/AIN functions as an analog input channel. When REFSEL[1:0] = 01 or 11, REF2/AIN_functions as the device's negative reference.

Temperature Measurements Issue a command byte setting bit 0 of the conversion register to one to take a temperature measurement. See Table 4. The MAX1040-MAX1043/MAX1046MAX1049 perform temperature measurements with an internal diode-connected transistor. The diode bias current changes from $68 \mu \mathrm{~A}$ to $4 \mu \mathrm{~A}$ to produce a tempera-ture-dependent bias voltage difference. The second conversion result at $4 \mu \mathrm{~A}$ is subtracted from the first at $68 \mu \mathrm{~A}$ to calculate a digital value that is proportional to absolute temperature. The output data appearing at DOUT is the digital code above, minus an offset to adjust from Kelvin to Celsius.
The reference voltage used for the temperature measurements is always derived from the internal reference source to ensure that 1 LSB corresponds to $1 / 8$ th of a degree Celsius. On every scan where a temperature measurement is requested, the 12-bit temperature conversion is carried out first. The first 2 bytes of data read from the FIFO contain the result of the 12-bit temperature measurement. If another temperature measurement is performed before the first temperature result is read out, the old measurement is overwritten by the new result. Temperature results are in degrees Celsius (two's complement). See the Applications Information section for information on how to perform temperature measurements in each clock mode.

## Register Descriptions

 The MAX1040-MAX1043/MAX1046-MAX1049 communicate between the internal registers and the external circuitry through the SPI-compatible serial interface. Table 1 details the command byte, the registers, and the bit names. Tables 4-12 show the various functions within the conversion register, setup register, unipolarmode register, bipolar-mode register, ADC averaging register, DAC select register, reset register, and GPIO command register, respectively.Conversion Register
Select active analog input channels, scan modes, and a single temperature measurement per scan by issuing

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a command byte to the conversion register. Table 4 details channel selection, the four scan modes, and how to request a temperature measurement. Start a scan by writing to the conversion register when in clock mode 10 or 11, or by applying a low pulse to the CNVST pin when in clock mode 00 or 01 . See Figures 6 and 7 for timing specifications for starting a scan with CNVST.

A conversion is not performed if it is requested on a channel or one of the channel pairs that has been configured as CNVST or REF2. For channels configured as differential pairs, the CHSELO bit is ignored and the two pins are treated as a single differential channel. For the MAX1046-MAX1049, the CHSEL2 bit must be zero. Channels 4-7 are invalid. Any scans or averages on these channles can cause corrupt data.
Select scan mode 00 or 01 to return one result per sin-gle-ended channel and one result per differential pair within the selected scanning range (set by bits 2 and 1 , SCAN1 and SCANO), plus one temperature result if selected. Select scan mode 10 to scan a single input channel numerous times, depending on NSCAN1 and NSCANO in the ADC averaging register (Table 9). Select scan mode 11 to return only one result from a single channel.

## Setup Register

 Issue a command byte to the setup register to configure the clock, reference, power-down modes, and ADC single-ended/differential modes. Table 5 details the bits in the setup-register command byte. Bits 5 and 4 (CKSEL1 and CKSELO) control the clock mode, acquisition and sampling, and the conversion start. Bits 3 and 2 (REFSEL1 and REFSELO) set the device for either internal or external reference. Bits 1 and 0 (DIFFSEL1 and DIFFSELO) address the ADC unipolar-mode and bipolar-mode registers and configure the analog-input channels for differential operation.The ADC reference is always on if any of the following conditions are true:

1) The FBGON bit is set to one in the reset register.
2)At least one DAC output is powered up and REFSEL[1:0] (in the setup register) $=00$.
2) At least one DAC is powered down through the $100 \mathrm{k} \Omega$ to $\mathrm{V}_{\text {REF }}$ and REFSEL[1:0] $=00$.
If any of the above conditions exist, the ADC reference is always on, but there is a 188 clock-cycle delay before temperature-sensor measurements begin, if requested.

Table 4. Conversion Register*

| BIT <br> NAME | BIT | FUNCTION |
| :---: | :---: | :--- |
| - | 7 (MSB) | Set to one to select conversion register. |
| X | 6 | Don't care. |
| CHSEL2 | 5 | Analog-input channel select. <br> (MAX1040-MAX1043). Set to 0 on <br> MAX1046-MAX1049 |
| CHSEL1 | 4 | Analog-input channel select. |
| CHSEL0 | 3 | Analog-input channel select. |
| SCAN1 | 2 | Scan-mode select. |
| SCAN0 | 1 | Scan-mode select. <br> TEMP <br> 0 (LSB)Set to one to take a single temp- <br> erature measurement. The first <br> conversion result of a scan contains <br> temperature information. |

*See below for bit details.

| CHSEL2 $^{\star *}$ | CHSEL1 | CHSELO | SELECTED <br> CHANNEL <br> (N) |
| :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | AIN0 |
| 0 | 0 | 1 | AIN1 |
| 0 | 1 | 0 | AIN2 |
| 0 | 1 | 1 | AIN3 |
| 1 | 0 | 0 | AIN4 |
| 1 | 0 | 1 | AIN5 |
| 1 | 1 | 0 | AIN6 |
| 1 | 1 | 1 | AIN7 |

${ }^{* *}$ Channels 4-7 are invalid on the MAX1046-MAX1049. Set CHSEL2 bit to 0 on those devices.

| SCAN1 | SCAN0 | SCAN MODE <br> (CHANNEL N IS SELECTED BY <br> BITS CHSEL2, CHSEL1, AND CHSELO) <br> 0 $0^{\text {Scans channels 0 through N. }}$ |
| :---: | :---: | :--- |
| 0 | 1 | Scans channels N through the highest <br> numbered channel. |
| 1 | 0 | Scans channel N repeatedly. The ADC <br> averaging register sets the number of <br> results. |
| 1 | 1 | No scan. Converts channel N once only. |

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Table 5. Setup Register*

| BIT NAME | BIT | FUNCTION |
| :---: | :---: | :--- |
| - | $7(\mathrm{MSB})$ | Set to zero to select setup register. |
| - | 6 | Set to one to select setup register. |
| CKSEL1 | 5 | Clock mode and $\overline{\text { CNVST configuration; resets to one at power-up. }}$ |
| CKSEL0 | 4 | Clock mode and $\overline{\text { CNVST configuration. }}$ |
| REFSEL1 | 3 | Reference-mode configuration. |
| REFSEL0 | 2 | Reference-mode configuration. |
| DIFFSEL1 | 1 | Unipolar-/bipolar-mode register configuration for differential mode. |
| DIFFSELO | $0(\mathrm{LSB})$ | Unipolar-/bipolar-mode register configuration for differential mode. |

*See below for bit details.
Table 5a. Clock Modes (see the Clock Modes section)

| CKSEL1 | CKSELO | CONVERSION CLOCK | ACQUISITION/SAMPLING | $\overline{\text { CNVST CONFIGURATION }}$ |
| :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | Internal | Internally timed. | $\overline{\text { CNVST }}$ |
| 0 | 1 | Internal | Externally timed by $\overline{\text { CNVST. }}$ | $\overline{\text { CNVST }}$ |
| 1 | 0 | Internal | Internally timed. | $\overline{\text { AIN7 }}$ |
| 1 | 1 | External $(4.8 \mathrm{MHz}$ max $)$ | Externally timed by SCLK. | AIN7 |

Table 5b. Clock Modes 00, 01, and 10

| REFSEL1 | REFSELO | VOLTAGE REFERENCE | OVERRIDE CONDITIONS | AUTOSHUTDOWN | REF2 CONFIGURATION |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | Internal (DAC and ADC) | AIN | Internal reference turns off after scan is complete. If internal reference is turned off, there is a programmed delay of 218 internal-conversion clock cycles. | AIN6 |
|  |  |  | Temperature | Internal reference required. There is a programmed delay of 244 internal-conversion clock cycles for the internal reference to settle after wake-up. |  |
| 0 | 1 | External singleended (REF1 for DAC and REF2 for ADC) | AIN | Internal reference not used. | REF2 |
|  |  |  | Temperature | Internal reference required. There is a programmed delay of 244 internal-conversion clock cycles for the internal reference to settle after wake-up. |  |
| 1 | 0 | Internal (ADC) and external <br> REF1 (DAC) | AIN | Default reference mode. Internal reference turns off after scan is complete. If internal reference is turned off, there is a programmed delay of 218 internalconversion clock cycles. | AIN6 |
|  |  |  | Temperature | Internal reference required. There is a programmed delay of 244 internal-conversion clock cycles for the internal reference to settle after wake-up. |  |
| 1 | 1 | External differential (ADC), external REF1 (DAC) | AIN | Internal reference not used. | REF2 |
|  |  |  | Temperature | Internal reference required. There is a programmed delay of 244 internal-conversion clock cycles for the internal reference to settle after wake-up. |  |

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Table 5c. Clock Mode 11

| REFSEL1 | REFSELO | VOLTAGE REFERENCE | OVERRIDE CONDITIONS | AUTOSHUTDOWN | REF2 CONFIGURATION |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | Internal (DAC and ADC) | AIN | Internal reference turns off after scan is complete. If internal reference is turned off, there is a programmed delay of 218 external conversion clock cycles. | AIN6 |
|  |  |  | Temperature | Internal reference required. There is a programmed delay of 244 external conversion clock cycles for the internal reference. Temperature-sensor output appears at DOUT after 188 further external clock cycles. |  |
| 0 | 1 | External singleended (REF1 for DAC and REF2 for ADC) | AIN | Internal reference not used. |  |
|  |  |  | Temperature | Internal reference required. There is a programmed delay of 244 external conversion clock cycles for the internal reference. Temperature-sensor output appears at DOUT after 188 further external clock cycles. | REF2 |
| 1 | 0 | Internal (ADC) and external REF1 (DAC) | AIN | Default reference mode. Internal reference turns off after scan is complete. If internal reference is turned off, there is a programmed delay of 218 external conversion clock cycles. | AIN6 |
|  |  |  | Temperature | Internal reference required. There is a programmed delay of 244 external conversion clock cycles for the internal reference. Temperature-sensor output appears at DOUT after 188 further external clock cycles. |  |
| 1 | 1 | External differential (ADC), external REF1 (DAC) | AIN | Internal reference not used. |  |
|  |  |  | Temperature | Internal reference required. There is a programmed delay of 244 external conversion clock cycles for the internal reference. Temperature-sensor output appears at DOUT after 188 further external clock cycles. | REF2 |

Table 5d. Differential Select Modes

| DIFFSEL1 | DIFFSELO | FUNCTION |
| :---: | :---: | :--- |
| 0 | 0 | No data follows the command setup byte. Unipolar-mode and bipolar-mode registers remain unchanged. |
| 0 | 1 | No data follows the command setup byte. Unipolar-mode and bipolar-mode registers remain unchanged. |
| 1 | 0 | 1 byte of data follows the command setup byte and is written to the unipolar-mode register. |
| 1 | 1 | 1 byte of data follows the command setup byte and is written to the bipolar-mode register. |

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Table 6. Unipolar-Mode Register (Addressed Through the Setup Register)

| BIT NAME | BIT | FUNCTION |
| :---: | :---: | :--- |
| UCH0/1 | 7 (MSB) | Configure AIN0 and AIN1 for unipolar differential conversion. |
| UCH2/3 | 6 | Configure AIN2 and AIN3 for unipolar differential conversion. |
| UCH4/5 | 5 | Configure AIN4 and AIN5 for unipolar differential conversion (MAX1040-MAX1043). Set UCH4/5 to <br> 0 on the MAX1046-MAX1049. |
| UCH6/7 | 4 | Configure AIN6 and AIN7 for unipolar differential conversion (MAX1040-MAX1043). Set UCH6/7 to <br> 0 on the MAX1046-MAX1049. |
| X | 3 | Don't care. |
| X | 2 | Don't care. |
| X | 1 | Don't care. |
| X | 0 (LSB) | Don't care. |

Table 7. Bipolar-Mode Register (Addressed Through the Setup Register)

| BIT NAME | BIT | FUNCTION |
| :---: | :---: | :--- |
| BCH0/1 | 7 (MSB) | Set to one to configure AIN0 and AIN1 for bipolar differential conversion. Set the corresponding bits <br> in the unipolar-mode and bipolar-mode registers to zero to configure AIN0 and AIN1 for unipolar <br> single-ended conversion. |
| BCH2/3 | 6 | Set to one to configure AIN2 and AIN3 for bipolar differential conversion. Set the corresponding bits <br> in the unipolar-mode and bipolar-mode registers to zero to configure AIN2 and AIN3 for unipolar <br> single-ended conversion. |
| BCH4/5 | 5 | Set to one to configure AIN4 and AIN5 for bipolar differential conversion (MAX1040-MAX1043). Set <br> the corresponding bits in the unipolar-mode and bipolar-mode registers to zero to configure AIN4 <br> and AIN5 for unipolar single-ended conversion. Set BCH4/5 to 0 on the MAX1046-MAX1049. |
| BCH6/7 | 4 | Set to one to configure AIN6 and AIN7 for bipolar differential conversion (MAX1040-MAX1043). Set <br> the corresponding bits in the unipolar-mode and bipolar-mode registers to zero to configure AIN6 <br> and AIN7 for unipolar single-ended conversion. Set BCH6/7 to 0 on the MAX1046-MAX1049. |
| X | 3 | Don't care. |
| X | 2 | Don't care. |
| X | 1 | Don't care. |
| X | 0 (LSB) | Don't care. |

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## Unipolar/Bipolar Registers

 The final 2 bits (LSBs) of the setup register control the unipolar-/bipolar-mode address registers. Set DIFFSEL[1:0] = 10 to write to the unipolar-mode register. Set bits DIFFSEL[1:0] = 11 to write to the bipolarmode register. In both cases, the setup command byte must be followed by 1 byte of data that is written to the unipolar-mode register or bipolar-mode register. Hold $\overline{\mathrm{CS}}$ low and run 16 SCLK cycles before pulling $\overline{\mathrm{CS}}$ high.Table 8. Unipolar/Bipolar Channel Function

| UNIPOLAR- <br> MODE <br> REGISTER BIT | BIPOLAR-MODE <br> REGISTER BIT | CHANNEL PAIR <br> FUNCTION |
| :---: | :---: | :---: |
| 0 | 0 | Unipolar single ended |
| 0 | 1 | Bipolar differential |
| 1 | 0 | Unipolar differential |
| 1 | 1 | Unipolar differential |

If the last 2 bits of the setup register are 00 or 01 , neither the unipolar-mode register nor the bipolar-mode register is written. Any subsequent byte is recognized as a new command byte. See Tables 6, 7, and 8 to program the unipolar- and bipolar-mode registers.
Both registers power up at all zeros to set the inputs as eight unipolar single-ended channels. To configure a channel pair as single-ended unipolar, bipolar differential, or unipolar differential, see Table 8.
In unipolar mode, AIN+ can exceed AIN- by up to $V_{\text {REF }}$. The output format in unipolar mode is binary. In bipolar mode, either input can exceed the other by up to $\mathrm{V}_{\mathrm{REF}} / 2$. The output format in bipolar mode is two's complement (see the ADC Transfer Functions section).

ADC Averaging Register
Write a command byte to the ADC averaging register to configure the ADC to average up to 32 samples for each requested result, and to independently control the number of results requested for single-channel scans.

## Table 9. ADC Averaging Register*

| BIT NAME | BIT |  |
| :---: | :---: | :--- |
| - | $7(\mathrm{MSB})$ | Set to zero to select ADC averaging register. |
| - | 6 | Set to zero to select ADC averaging register. |
| - | 5 | Set to one to select ADC averaging register. |
| AVGON | 4 | Set to one to turn averaging on. Set to zero to turn averaging off. |
| NAVG1 | 3 | Configures the number of conversions for single-channel scans. |
| NAVG0 | 2 | Configures the number of conversions for single-channel scans. |
| NSCAN1 | 1 | Single-channel scan count. (Scan mode 10 only.) |
| NSCAN0 | $0(\mathrm{LSB})$ | Single-channel scan count. (Scan mode 10 only.) |

*See below for bit details.

| AVGON | NAVG1 | NAVGO | FUNCTION |
| :---: | :---: | :---: | :--- |
| 0 | $X$ | X | Performs one conversion for each requested result. |
| 1 | 0 | 0 | Performs four conversions and returns the average for each requested result. |
| 1 | 0 | 1 | Performs eight conversions and returns the average for each requested result. |
| 1 | 1 | 0 | Performs 16 conversions and returns the average for each requested result. |
| 1 | 1 | 1 | Performs 32 conversions and returns the average for each requested result. |


| NSCAN1 | NSCAN0 | FUNCTION (APPLIES ONLY IF SCAN MODE 10 IS SELECTED) |
| :---: | :---: | :--- |
| 0 | 0 | Scans channel N and returns four results. |
| 0 | 1 | Scans channel N and returns eight results. |
| 1 | 0 | Scans channel N and returns 12 results. |
| 1 | 1 | Scans channel N and returns 16 results. |

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Table 9 details the four scan modes available in the ADC conversion register. All four scan modes allow averaging as long as the AVGON bit, bit 4 in the averaging register, is set to 1 . Select scan mode 10 to scan the same channel multiple times. Clock mode 11 disables averaging. For example, if AVGON $=1$, NAVG[1:0] = 00, NSCAN [1:0] = 11 and SCAN [1:0] = 10, 16 results are written to the FIFO, with each result being the average of four conversions of channel N .

## DAC Select Register

Write a command byte 0001XXXX to the DAC select register (as shown in Table 9) to set up the DAC interface and indicate that another word will follow. The last 4 bits of the DAC select register are don't-care bits. The word that follows the DAC select-register command byte controls the DAC serial interface. See Table 17 and the DAC Serial Interface section.

## Table 10. DAC Select Register

| BIT <br> NAME | BIT | FUNCTION |
| :---: | :---: | :--- |
| - | $7(\mathrm{MSB})$ | Set to zero to select DAC select register. |
| - | 6 | Set to zero to select DAC select register. |
| - | 5 | Set to zero to select DAC select register. |
| - | 4 | Set to one to select DAC select register. |
| $X$ | 3 | Don't care. |
| $X$ | 2 | Don't care. |
| $X$ | 1 | Don't care. |
| $X$ | 0 | Don't care. |

Table 11. Reset Register

| BIT <br> NAME | BIT | FUNCTION |
| :---: | :---: | :--- |
| - | $7(\mathrm{MSB})$ | Set to zero to select ADC reset register. |
| - | 6 | Set to zero to select ADC reset register. |
| - | 5 | Set to zero to select ADC reset register. |
| - | 4 | Set to zero to select ADC reset register. |
| - | 3 | Set to one to select ADC reset register. |
| RESET | 2 | Set to zero to clear the FIFO only. Set to <br> one to set the device in its power-on <br> condition. |
| SLOW | 1 | Set to one to turn on slow mode. |
| FBGON | 0 (LSB) | Set to one to force internal bias block and <br> bandgap reference to be always powered <br> up. |

Reset Register Write to the reset register (as shown in Table 11) to clear the FIFO or to reset all registers to their default states. Set the RESET bit to one to reset the FIFO. Set the RESET bit to zero to return the MAX1040-MAX1043/ MAX1046-MAX1049 to their default power-up state. All registers power up in state 00000000, except for the setup register that powers up in clock mode 10 (CKSEL1 = 1). Set the SLOW bit to one to add a 15 ns delay in the DOUT signal path to provide a longer hold time. Writing a one to the SLOW bit also clears the contents of the FIFO. Set the FBGON bit to one to force the bias block and bandgap reference to power up regardless of the state of the DAC and activity of the ADC block. Setting the FBGON bit high also removes the programmed wake-up delay between conversions in clock modes 01 and 11. Setting the FBGON bit high also clears the FIFO.

GPIO Command
Write a command byte to the GPIO command register to configure, write, or read the GPIOs, as detailed in Table 12.
Write the command byte 00000011 to configure the GPIOs. The eight SCLK cycles following the command byte load data from DIN to the GPIO configuration register in the MAX1042/MAX1043/MAX1048/MAX1049.

Table 12. GPIO Command Register

| BIT NAME | BIT | FUNCTION |
| :---: | :---: | :--- |
| - | $7(\mathrm{MSB})$ | Set to zero to select GPIO register. |
| - | 6 | Set to zero to select GPIO register. |
| - | 5 | Set to zero to select GPIO register. |
| - | 4 | Set to zero to select GPIO register. |
| - | 3 | Set to zero to select GPIO register. |
| - | 2 | Set to zero to select GPIO register. |
| GPIOSEL1 | 1 | GPIO configuration bit. |
| GPIOSEL2 | $0(\mathrm{LSB})$ | GPIO write bit. |


| GPIOSEL1 | GPIOSEL2 | FUNCTION |
| :---: | :---: | :--- |
| 1 | 1 | GPIO configuration; written data is <br> entered in the GPIO configuration <br> register. |
| 1 | 0 | GPIO write; written data is entered <br> in the GPIO write register. |
| 0 | 1 | GPIO read; the next 8 SCLK cycles <br> transer the state of all GPIO <br> drivers into DOUT. |

# 10-Bit, Multichannel ADCs/DACs with FIFO, Temperature Sensing, and GPIO Ports 

See Tables 13 and 14. The register bits are updated after the last $\overline{\mathrm{CS}}$ rising edge. All GPIOs default to inputs upon power-up.
The data in the register controls the function of each GPIO, as shown in Tables 13, 14, and 16.

GPIO Write
Write the command byte 00000010 to indicate a GPIO write operation. The eight SCLK cycles following the command byte load data from DIN into the GPIO write register in the MAX1042/MAX1043/MAX1048/MAX1049. See Tables 14 and 15. The register bits are updated after the last $\overline{\mathrm{CS}}$ rising edge.

GPIO Read
Write the command byte 00000001 to indicate a GPIO read operation. The eight SCLK cycles following the command byte transfer the state of the GPIOs to DOUT in the MAX1042/MAX1043/MAX1048/MAX1049. See Table 16.

DAC Serial Interface
Write a command byte 0001XXXX to the DAC select register to indicate the word to follow is written to the DAC serial interface, as detailed in Tables 1, 10, 17, and 18. Write the next 16 bits to the DAC interface register, as shown in Tables 17 and 18. Following the high-to-low transition of $\overline{\mathrm{CS}}$, the data is shifted synchronously and latched into the input register on each falling edge of SCLK. Each word is 16 bits. The first 4 bits are the control bits, followed by 10 data bits (MSB first), followed by 2 sub-bits. See Figures 9-12 for DAC timing specifications.
If $\overline{\mathrm{CS}}$ goes high prior to completing 16 SCLK cycles, the command is discarded. To initiate a new transfer, drive $\overline{\mathrm{CS}}$ low again.
For example, writing the DAC serial interface word 1111 0000 and 00110100 disconnects DAC outputs 2 and 3 and forces them to a high-impedance state. DAC outputs 0 and 1 remain in their previous state.

Table 13. MAX1042/MAX1043/MAX1048/MAX1049 GPIO Configuration

| DATA PIN | GPIO COMMAND BYTE |  |  |  |  | DATA BYTE |  |  |  |  |  |  |  |  |  |  |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DIN | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | GPIOC1 | GPIOC0 | GPIOA1 | GPIOA0 | X | X | X | X |
| DOUT | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

## Table 14. MAX1042/MAX1043/MAX1048/MAX1049 GPIO Write

| DATA PIN | GPIO COMMAND BYTE |  |  |  |  |  |  |  | DATA BYTE |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DIN | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | GPIOC1 | GPIOC0 | GPIOA1 | GPIOAO | X | X | X | X |
| DOUT | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

## Table 15. GPIO-Mode Control

| CONFIGURATION <br> BIT | WRITE <br> BIT | OUTPUT <br> STATE | GPIO <br> FUNCTION |
| :---: | :---: | :---: | :---: |
| 1 | 1 | 1 | Output |
| 1 | 0 | 0 | Output |
| 0 | 1 | Tri-state | Input |
| 0 | 0 | 0 | Pulldown <br> (open drain) |

Table 16. MAX1042/MAX1043/MAX1048/MAX1049 GPIO Read

| DATA PIN | GPIO COMMAND BYTE |  |  |  |  |  |  |  | DATA BYTE |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DIN | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | X | X | X | X | X | X | X | X |
| DOUT | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | GPIOC1 | GPIOC0 | GPIOA1 | GPIOA0 |

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Table 17. DAC Serial-Interface Configuration

| 16-BIT SERIAL WORD |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  | DESCRIPTION | FUNCTION |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| MSB LSB |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| CONTROL BITS |  |  |  | DATA BITS |  |  |  |  |  |  |  |  |  |  |  |  |  |
| C3 | C2 | C1 | CO | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | X | X |  |  |
| 0 | 0 | 0 | 0 | X | X | X | X | X | X | X | X | X | X | X | X | NOP | No Operation. |
| 0 | 0 | 0 | 1 | 0 | X | X | X | X | X | X | X | X | X | X | X | RESET | Reset all internal registers to 000h and leave output buffers in their present state. |
| 0 | 0 | 0 | 1 | 1 | X | X | X | X | X | X | X | X | X | X | X | Pull-High | Preset all internal registers to FFFh and leave output buffers in their present state. |
| 0 | 0 | 1 | 0 | - | - | - | - | - | - | - | - | - | - | X | X | DAC0 | D9-D0 to input register 0, DAC output unchanged. |
| 0 | 0 | 1 | 1 | - | - | - | - | - | - | - | - | - | - | X | X | DAC1 | D9-D0 to input register 1, DAC output unchanged. |
| 0 | 1 | 0 | 0 | - | - | - | - | - | - | - | - | - | - | X | X | DAC2 | D9-D0 to input register 2, DAC output unchanged. |
| 0 | 1 | 0 | 1 | - | - | - | - | - | - | - | - | - | - | X | X | DAC3 | D9-D0 to input register 3, DAC output unchanged. |
| 0 | 1 | 1 | 0 | X | X | X | X | X | X | X | X | X | X | X | X | NOP | No Operation. |
| 0 | 1 | 1 | 1 | X | X | X | X | X | X | X | X | X | X | X | X | NOP | No Operation. |
| 1 | 0 | 0 | 0 | X | X | X | X | X | X | X | X | X | X | X | X | NOP | No Operation. |
| 1 | 0 | 0 | 1 | X | X | X | X | X | X | X | X | X | X | X | X | NOP | No Operation. |
| 1 | 0 | 1 | 0 | - | - | - | - | - | - | - | - | - | - | X | X | DAC0-DAC3 | D9-D0 to input registers 0-3 and DAC register 0-3. DAC outputs updated (write-through). |
| 1 | 0 | 1 | 1 | X | X | X | X | X | X | X | X | X | X | X | X | NOP | No Operation. |
| 1 | 1 | 0 | 0 | - | - | - | - | - | - | - | - | - | - | X | X | DAC0-DAC3 | D9-D0 to input registers 0-3 and DAC Register 0-3. DAC outputs updated (write-through). |
| 1 | 1 | 0 | 1 | - | - | - | - | - | - | - | - | - | - | X | X | DAC0-DAC3 | D9-D0 to input registers 0-3. DAC outputs unchanged. |
| 1 | 1 | 1 | 0 | X | X | X | X | O | Ñ | $\overline{\mathrm{O}}$ | $\begin{aligned} & \mathrm{O} \\ & \hline 1 \end{aligned}$ | X | X | X | X | DAC0-DAC3 | Input registers to DAC registers indicated by ones, DAC outputs updated, equivalent to software $\overline{\mathrm{LDAC}}$. (No effect on DACs indicated by zeros.) |

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Table 18. DAC Power-Up and Power-Down Commands

|  | ON1 | $\begin{aligned} & \text { TRO } \\ & \text { TS } \end{aligned}$ |  | DATA BITS |  |  |  |  |  |  |  |  |  |  |  | DESCRIPTION | FUNCTION |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| C3 | C2 | C1 | CO | X | X | X | X | $\begin{gathered} \substack{0 \\ \mathbb{O} \\ \hline} \end{gathered}$ | $\begin{gathered} \tilde{\mathrm{O}} \\ \mathrm{Q} \end{gathered}$ | $\begin{aligned} & \bar{U} \\ & \mathbf{U} \end{aligned}$ | $\begin{gathered} 0 \\ 0 \\ 0 \\ 0 \end{gathered}$ | D3 | D2 | D1 | D0 |  |  |
| 1 | 1 | 1 | 1 | X | X | X | X | - | - | - | - | 0 | 0 | 1 | X | Power-Up | Power up individual DAC buffers indicated by data in DAC0 through DAC3. A one indicates the DAC output is connected and active. A zero does not affect the DAC's present state. |
| 1 | 1 | 1 | 1 | X | X | X | X | - | - | - | - | 0 | 1 | 0 | X | Power-Down 1 | Power down individual DAC buffers indicated by data in DAC0 through DAC3. A one indicates the DAC output is disconnected and high impedance. A zero does not affect the DAC's present state. |
| 1 | 1 | 1 | 1 | X | X | X | X | - | - | - | - | 1 | 0 | 0 | X | Power-Down 2 | Power down individual DAC buffers indicated by data in DAC0 through DAC3. A one indicates the DAC output is disconnected and pulled to AGND with a $1 \mathrm{k} \Omega$ resistor. A zero does not affect the DAC's present state. |
| 1 | 1 | 1 | 1 | X | X | X | X | - | - | - | - | 0 | 0 | 0 | X | Power-Down 3 | Power down individual DAC buffers indicated by data in DAC0 through DAC3. A one indicates the DAC output is disconnected and pulled to AGND with a $100 \mathrm{k} \Omega$ resistor. A zero does not affect the DAC's present state. |
| 1 | 1 | 1 | 1 | X | X | X | X | - | - | - | - | 1 | 1 | 1 | X | Power-Down 4 | Power down individual DAC buffers indicated by data in DACO through DAC3. A one indicates the DAC output is disconnected and pulled to REF1 with a $100 \mathrm{k} \Omega$ resistor. A zero does not affect the DAC's present state. |

Output-Data Format
Figures 6-9 illustrate the conversion timing for the MAX1040-MAX1043/MAX1046-MAX1049. All 10-bit conversion results are output in 2-byte format, MSB first, with four leading zeros and the LSB followed by 2 sub-bits. Data appears on DOUT on the falling edges of SCLK. Data is binary for unipolar mode and two's complement for bipolar mode and temperature results. See Figures 3, 4, and 5 for input/output and tempera-ture-transfer functions.

## ADC Transfer Functions

Figure 3 shows the unipolar transfer function for singleended or differential inputs. Figure 4 shows the bipolar
transfer function for differential inputs. Code transitions occur halfway between successive-integer LSB values. Output coding is binary, with 1 LSB = VREF1 / 1024 for unipolar and bipolar operation, and $1 \mathrm{LSB}=+0.125^{\circ} \mathrm{C}$ for temperature measurements. Bipolar true-differential results and temperature-sensor results are available in two's complement format, while all others are in binary. See Tables 6, 7, and 8 for details on which setting (unipolar or bipolar) takes precedence.
In unipolar mode, AIN+ can exceed AIN- by up to VREF1. In bipolar mode, either input can exceed the other by up to $\mathrm{V}_{\text {REF1/ }}$ /2.

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Partial Reads and Partial Writes If the first byte of an entry in the FIFO is partially read ( $\overline{C S}$ is pulled high after fewer than eight SCLK cycles), the remaining bits are lost for that byte. The next byte of data that is read out contains the next 8 bits. If the first byte of an entry in the FIFO is read out fully, but the second byte is read out partially, the rest of that byte is lost. The remaining data in the FIFO is unaffected and can be read out normally after taking $\overline{\mathrm{CS}}$ low again, as long as the 4 leading bits (normally zeros) are ignored. If $\overline{\mathrm{CS}}$ is pulled low before EOC goes low, a conversion may not be completed and the FIFO data may not be correct. Incorrect writes (pulling $\overline{\mathrm{CS}}$ high before completing eight SCLK cycles) are ignored and the register remains unchanged.

## Applications Information

## Internally Timed Acquisitions and Conversions Using CNVST

ADC Conversions in Clock Mode 00 In clock mode 00, the wake-up, acquisition, conversion, and shutdown sequence is initiated through CNVST and performed automatically using the internal oscillator. Results are added to the internal FIFO to be read out later. See Figure 6 for clock mode 00 timing after a command byte is issued. See Table 5 for details on programming the clock mode in the setup register.
Initiate a scan by setting CNVST low for at least 40 ns before pulling it high again. The MAX1040-MAX1043/


Figure 3. Unipolar Transfer Function-Full Scale (FS) = VREF

MAX1046-MAX1049 then wake up, scan all requested channels, store the results in the FIFO, and shut down. After the scan is complete, $\overline{E O C}$ is pulled low and the results are available in the FIFO. Wait until EOC goes low before pulling $\overline{\mathrm{CS}}$ low to communicate with the serial interface. EOC stays low until $\overline{\mathrm{CS}}$ or $\overline{\text { CNVST }}$ is pulled low again. A temperature-conversion result, if requested, precedes all other FIFO results. Temperature results are available in 12-bit format.


Figure 4. Bipolar Transfer Function-Full Scale ( $\pm F S$ ) $= \pm V_{R E F} / 2$


Figure 5. Temperature Transfer Function

## 10-Bit, Multichannel ADCs/DACs with FIFO, Temperature Sensing, and GPIO Ports



Figure 6. Clock Mode 00—After writing a command byte, set $\overline{C N V S T}$ low for at least 40ns to begin a conversion.


Figure 7. Clock Mode 01—After writing a command byte, request multiple conversions by setting $\overline{C N V S T}$ low for each conversion.

Do not issue a second $\overline{\text { CNVST }}$ signal before $\overline{\mathrm{EOC}}$ goes low; otherwise, the FIFO can be corrupted. Wait until all conversions are complete before reading the FIFO. SPI communications to the DAC and GPIO registers are permitted during conversion. However, coupled noise may result in degraded ADC signal-to-noise ratio (SNR).

## Externally Timed Acquisitions and Internally Timed Conversions with CNVST <br> ADC Conversions in Clock Mode 01

In clock mode 01, conversions are requested one at a time using CNVST and performed automatically using the internal oscillator. See Figure 7 for clock mode 01 timing after a command byte is issued.
Setting CNVST low begins an acquisition, wakes up the ADC, and places it in track mode. Hold CNVST low for
at least $1.4 \mu \mathrm{~s}$ to complete the acquisition. If reference mode 00 or 10 is selected, an additional $45 \mu$ s is required for the internal reference to power up. If a temperature measurement is being requested, reference power-up and temperature measurement is internally timed. In this case, hold CNVST low for at least 40ns.
Set CNVST high to begin a conversion. Sampling is completed approximately 500ns after CNVST goes high. After the conversion is complete, the ADC shuts down and pulls $\overline{E O C}$ low. $\overline{\mathrm{EOC}}$ stays low until $\overline{\mathrm{CS}}$ or CNVST is pulled low again. Wait until EOC goes low before pulling $\overline{\mathrm{CS}}$ or $\overline{\mathrm{CNVST}}$ low. The number of $\overline{\mathrm{CNVST}}$ signals must equal the number of conversions requested by the scan and averaging registers to correctly update the FIFO. Wait until all conversions are complete before reading the FIFO. SPI communications to the DAC and GPIO registers are permitted during con-

## 10-Bit, Multichannel ADCs/DACs with FIFO, Temperature Sensing, and GPIO Ports



Figure 8. Clock Mode 10—The command byte to the conversion register begins the acquisition (ㄷNVST is not required).
version. However, coupled noise may result in degraded ADC SNR.
If averaging is turned on, multiple CNVST pulses need to be performed before a result is written to the FIFO. Once the proper number of conversions has been performed to generate an averaged FIFO result (as specified to the averaging register), the scan logic automatically switches the analog-input multiplexer to the next requested channel. If a temperature measurement is programmed, it is performed after the first rising edge of CNVST following the command byte written to the conversion register. The temperature-conversion result is available on DOUT once EOC has been pulled low. Temperature results are available in 12-bit format.

## Internally Timed Acquisitions and Conversions Using the Serial Interface

 In clock mode 10, the wake-up, acquisition, conversion, and shutdown sequence is initiated by writing a command byte to the conversion register, and is performed automatically using the internal oscillator. This is the default clock mode upon power-up. See Figure 8 for clock mode 10 timing.Initiate a scan by writing a command byte to the conversion register. The MAX1040-MAX1043/MAX1046MAX1049 then power up, scan all requested channels, store the results in the FIFO, and shut down. After the scan is complete, $\overline{E O C}$ is pulled low and the results are available in the FIFO. If a temperature measurement is requested, the temperature result precedes all other FIFO results. Temperature results are available in 12-bit format. $\overline{E O C}$ stays low until $\overline{C S}$ is pulled low again. Wait until all conversions are complete before reading the FIFO. SPI communications to the DAC and GPIO registers are permitted during conversion. However, coupled noise may result in degraded ADC SNR.

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Figure 9. Clock Mode 11—Externally Timed Acquisition, Sampling, and Conversion without $\overline{C N V S T}$

## Externally Clocked Acquisitions and Conversions Using the Serial Interface <br> ADC Conversions in Clock Mode 11

 In clock mode 11, acquisitions and conversions are initiated by writing a command byte to the conversion register and are performed one at a time using the SCLK as the conversion clock. Scanning, averaging and the FIFO are disabled, and the conversion result is available at DOUT during the conversion. Output data is updated on the rising edge of SCLK in clock mode 11. See Figure 9 for clock mode 11 timing.Initiate a conversion by writing a command byte to the conversion register followed by 16 SCLK cycles. If $\overline{\mathrm{CS}}$ is pulsed high between the eighth and ninth cycles, the pulse width must be less than $100 \mu \mathrm{~s}$. To continuously convert at 16 cycles per conversion, alternate 1 byte of zeros (NOP byte) between each conversion byte. If 2 NOP bytes follow a conversion byte, the analog cells power down at the end of the second NOP. Set the FBGON bit to one in the reset register to keep the internal bias block powered.
If reference mode 00 is requested, or if an external reference is selected but a temperature measurement is being requested, wait $45 \mu$ s with $\overline{\mathrm{CS}}$ high after writing the conversion byte to extend the acquisition and allow the internal reference to power up. To perform a temperature measurement, write 24 bytes (192 cycles) of zeros after the conversion byte. The temperature result appears on DOUT during the last 2 bytes of the 192 cycles. Temperature results are available in 12-bit format.

Conversion-Time Calculations
The conversion time for each scan is based on a number of different factors: conversion time per sample, samples per result, results per scan, if a temperature measurement is requested, and if the external reference is in use. Use the following formula to calculate the total conversion time for an internally timed conversion in clock mode 00 and 10 (see the Electrical Characteristics, as applicable):

Total conversion time $=$ tCNV x nAVG x nSCAN + tTS + tINT-REF,SU
where:
tCNV = tDOV (where tDOV is dependent on clock mode and reference mode selected).
nAVG = samples per result (amount of averaging)
nSCAN $=$ number of times each channel is scanned; set to one unless [SCAN1, SCAN0] = 10
tTS = time required for temperature measurement $(53.1 \mu \mathrm{~s})$; set to zero if temperature measurement is not requested
tINT-REF,SU = tWU (external-reference wake-up); if a conversion using the external reference is requested
In clock mode 01, the total conversion time depends on how long CNVST is held low or high. Conversion time in externally clocked mode (CKSEL1, CKSELO = 11) depends on the SCLK period and how long $\overline{\mathrm{CS}}$ is held high between each set of eight SCLK cycles. In clock mode 01, the total conversion time does not include the time required to turn on the internal reference.

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Figure 10．DAC／GPIO Serial－Interface Timing（Clock Modes 00，01，and 10）

DAC／GPIO Timing
Figures 10－13 detail the timing diagrams for writing to the DAC and GPIOs．Figure 10 shows the timing speci－ fications for clock modes 00，01，and 10．Figure 11 shows the timing specifications for clock mode 11. Figure 12 details the timing specifications for the DAC input select register and 2 bytes to follow．Output data
is updated on the rising edge of SCLK in clock mode 11．Figure 13 shows the GPIO timing．Figure 14 shows the timing details of a hardware $\overline{\mathrm{LDAC}}$ command DAC－ register update．For a software－command DAC－register update，ts is valid from the rising edge of CS，which fol－ lows the last data bit in the software command word．

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Figure 11. DAC/GPIO Serial-Interface Timing (Clock Mode 11)


Figure 12. DAC-Select Register Byte and DAC Serial-Interface Word

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Figure 13. GPIO Timing


Figure 14. $\overline{L D A C}$ Functionality

LDAC Functionality
Drive $\overline{\text { LDAC }}$ low to transfer the content of the input registers to the DAC registers. Drive LDAC permanently low to make the DAC register transparent. The DAC output typically settles from zero to full scale within $\pm 1$ LSB after $2 \mu \mathrm{~s}$. See Figure 14.

Layout, Grounding, and Bypassing For best performance, use PC boards. Ensure that digital and analog signal lines are separated from each other. Do not run analog and digital signals parallel to one another (especially clock signals) or do not run digital lines underneath the MAX1040-MAX1043/ MAX1046-MAX1049 package. High-frequency noise in the AVDD power supply may affect performance. Bypass the AVDD supply with a $0.1 \mu \mathrm{~F}$ capacitor to AGND, close to the AVDD pin. Bypass the DVDD supply with a $0.1 \mu \mathrm{~F}$ capacitor to DGND, close to the DVDD pin. Minimize capacitor lead lengths for best supply-noise rejection. If the power supply is very noisy, connect a $10 \Omega$ resistor in series with the supply to improve powersupply filtering.

The MAX1040-MAX1043/MAX1046-MAX1049 thin QFN packages contain an exposed pad on the underside of the device. Connect this exposed pad to AGND. Refer to the MAX1258EVKIT for an example of proper layout.
$\qquad$
Integral Nonlinearity
Integral nonlinearity (INL) is the deviation of the values on an actual transfer function from a straight line. This straight line can be either a best-straight-line fit or a line drawn between the end points of the transfer function, once offset and gain errors have been nullified. INL for the MAX1040-MAX1043/MAX1046-MAX1049 is measured using the end-point method.

## Differential Nonlinearity

Differential nonlinearity (DNL) is the difference between an actual step width and the ideal value of 1 LSB. A DNL error specification of less than 1 LSB guarantees no missing codes and a monotonic transfer function.

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#### Abstract

Unipolar ADC Offset Error For an ideal converter, the first transition occurs at 0.5 LSB, above zero. Offset error is the amount of deviation between the measured first transition point and the ideal first transition point.


## Bipolar ADC Offset Error

While in bipolar mode, the ADC's ideal midscale transition occurs at AGND -0.5 LSB. Bipolar offset error is the measured deviation from this ideal value.

## ADC Gain Error

 Gain error is defined as the amount of deviation between the ideal transfer function and the measured transfer function, with the offset error removed and with a full-scale analog input voltage applied to the ADC, resulting in all ones at DOUT.DAC Offset Error
DAC offset error is determined by loading a code of all zeros into the DAC and measuring the analog output voltage.

DAC Gain Error
DAC gain error is defined as the amount of deviation between the ideal transfer function and the measured transfer function, with the offset error removed, when loading a code of all ones into the DAC.

Aperture Jitter
Aperture jitter ( $\mathrm{t}_{\mathrm{AJ}}$ ) is the sample-to-sample variation in the time between the samples.

Aperture Delay Aperture delay ( $\mathrm{t}_{\mathrm{AD}}$ ) is the time between the rising edge of the sampling clock and the instant when an actual sample is taken.

Signal-to-Noise Ratio
For a waveform perfectly reconstructed from digital samples, signal-to-noise ratio (SNR) is the ratio of full-scale analog input (RMS value) to the RMS quantization error (residual error). The ideal, theoretical minimum analog-to-digital noise is caused by quantization error only and results directly from the ADC's resolution ( N bits):

$$
S N R=(6.02 \times N+1.76) d B
$$

In reality, there are other noise sources besides quantization noise, including thermal noise, reference noise, clock jitter, etc. Therefore, SNR is calculated by taking the ratio of the RMS signal to the RMS noise. RMS noise includes all spectral components to the Nyquist frequency excluding the fundamental, the first five harmonics, and the DC offset.

## Signal-to-Noise Plus Distortion

Signal-to-noise plus distortion (SINAD) is the ratio of the fundamental input frequency's RMS amplitude to the RMS equivalent of all other ADC output signals:

$$
\text { SINAD }(\mathrm{dB})=20 \times \log \text { (SignalRMS } / \text { NoiserMS })
$$

## Effective Number of Bits

 Effective number of bits (ENOB) indicates the global accuracy of an ADC at a specific input frequency and sampling rate. An ideal ADC's error consists of quantization noise only. With an input range equal to the fullscale range of the ADC, calculate the ENOB as follows:$$
\text { ENOB }=(\text { SINAD }-1.76) / 6.02
$$

Total Harmonic Distortion Total harmonic distortion (THD) is the ratio of the RMS sum of the first five harmonics of the input signal to the fundamental itself. This is expressed as:

$$
\mathrm{THD}=20 \times \log \left[\sqrt{\left(\mathrm{V}_{2}^{2}+\mathrm{V}_{3}^{2}+\mathrm{V}_{4}{ }^{2}+\mathrm{V}_{5}^{2}+\mathrm{V}_{6}^{2}\right)} / \mathrm{V}_{1}\right]
$$

where $\mathrm{V}_{1}$ is the fundamental amplitude, and $\mathrm{V}_{2}$ through $V_{6}$ are the amplitudes of the first five harmonics.

## Spurious-Free Dynamic Range

Spurious-free dynamic range (SFDR) is the ratio of RMS amplitude of the fundamental (maximum signal component) to the RMS value of the next largest distortion component.

ADC Channel-to-Channel Crosstalk Bias the ON channel to midscale. Apply a full-scale sine wave test tone to all OFF channels. Perform an FFT on the ON channel. ADC channel-to-channel crosstalk is expressed in dB as the amplitude of the FFT spur at the frequency associated with the OFF channel test tone.

Intermodulation Distortion (IMD) IMD is the total power of the intermodulation products relative to the total input power when two tones, f1 and f2, are present at the inputs. The intermodulation products are (f1 $\pm \mathrm{f} 2$ ), ( $2 \times \mathrm{f} 1$ ), ( $2 \times \mathrm{f} 2$ ), ( $2 \times \mathrm{f} 1 \pm \mathrm{f} 2$ ), ( $2 \times \mathrm{f} 2 \pm$ f1). The individual input tone levels are at -7 dB FS.

## Small-Signal Bandwidth

A small -20 dB FS analog input signal is applied to an ADC so the signal's slew rate does not limit the ADC's performance. The input frequency is then swept up to the point where the amplitude of the digitized conversion result has decreased by -3dB. Note that the T/H performance is usually the limiting factor for the smallsignal input bandwidth.

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Full-Power Bandwidth
A large -0.5 dB FS analog input signal is applied to an ADC, and the input frequency is swept up to the point where the amplitude of the digitized conversion result has decreased by -3dB. This point is defined as fullpower input bandwidth frequency.

## DAC Digital Feedthrough

DAC digital feedthrough is the amount of noise that appears on the DAC output when the DAC digital control lines are toggled.

## ADC Power-Supply Rejection

ADC power-supply rejection (PSR) is defined as the shift in offset error when the power-supply is moved from the minimum operating voltage to the maximum operating voltage.

## DAC Power-Supply Rejection

DAC PSR is the amount of change in the converter's value at full-scale as the power-supply voltage changes from its nominal value. PSR assumes the converter's linearity is unaffected by changes in the powersupply voltage.

## Chip Information

TRANSISTOR COUNT: 58,141 PROCESS: BiCMOS

Ordering Information/Selector Guide

| PART | TEMP RANGE | PIN-PACKAGE | REF <br> VOLTAGE <br> (V) | ANALOG <br> SUPPLY <br> VOLTAGE (V) | RESOLUTION <br> BITS*** | ADC <br> CHANNELS | DAC <br> CHANNELS | GPIOs |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |

*Future product-contact factory for availability.
**EP = Exposed pad.
${ }^{* * *}$ Number of resolution bits refers to both DAC and ADC.

## 10-Bit, Multichannel ADCs/DACs with FIFO, Temperature Sensing, and GPIO Ports




TOP VIEW


TOP VIEW


## 10-Bit, Multichannel ADCs/DACs with FIFO, Temperature Sensing, and GPIO Ports

Package Information
(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)


## 10-Bit, Multichannel ADCs/DACs with FIFO, Temperature Sensing, and GPIO Ports

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)

| COMMON DIMENSIONS |  |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| PKG. | 36L 6x6 |  |  | 40L 6x6 |  |  | 48L 6x6 |  |  |
| SYMAOL | MIN. | NON. | MAX. | MIN. | NOM. | MAX. | MN. | NOM. | MAX. |
| A | 0.70 | 0.75 | 0.80 | 0.70 | 0.75 | 0.80 | 0.70 | 0.75 | 0.80 |
| AI | 0 | 0.02 | 0.05 | 0 | 0.02 | 0.05 | 0 | - | 0.05 |
| A2 | 0.20 REF. |  |  | 0.20 REF. |  |  | 0.20 REF. |  |  |
| $b$ | 0.20 | 0.25 | D.30 | 0.20 | 0.25 | 0.30 | 0.15 | 0.20 | 0.25 |
| D | 5.90 | 8.00 | 6.10 | 5.90 | 6.00 | 6.10 | 5.90 | 6.00 | 8.10 |
| E | 5.90 | 6.00 | 6.10 | 5.90 | 6.00 | 6.10 | 5.90 | 6.00 | 6.10 |
| e | 0.50 日SC. |  |  | 0.50 BSC. |  |  | 0.40 BSC. |  |  |
| k | 0.25 | - | - | 0.25 | - | - | 0.25 | 0.35 | 0.45 |
| L | 0.45 | 0.55 | 0.65 | 0.30 | 0.40 | 0.50 | 0.40 | 0.50 | 0.60 |
| LI | - | - | - | - | - | - | 0.30 | 0.40 | 0.50 |
| N | 36 |  |  | 40 |  |  | 48 |  |  |
| ND | 9 |  |  | 10 |  |  | 12 |  |  |
| NE | 9 |  |  | 10 |  |  | 12 |  |  |
| JEDEC | WUJD-1 |  |  | WUJD-2 |  |  | - |  |  |


| EXPOSED PAD VARIATIONS |  |  |  |  |  |  | $\begin{gathered} \text { DOWN } \\ \text { BONDS } \\ \text { A OWED } \end{gathered}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| PKG. CODES | D2 |  |  | E2 |  |  |  |
|  | MN. | NOM. | MAX. | MN. | NOM. | MAX. |  |
| T3666-1 | 3.60 | 3.70 | 3.80 | 3.60 | 3.70 | 3.80 | NO |
| T3666-2 | 3.60 | 3.70 | 3.80 | 3.60 | 3.70 | 3.80 | YES |
| T3666-3 | 3.60 | 3.70 | 3.80 | 3.60 | 3.70 | 3.80 | NO |
| T4066-1 | 4.00 | 4.10 | 4.20 | 4.00 | 4.10 | 4.20 | NO |
| T4066-2 | 4.00 | 4.10 | 4.20 | 4.00 | 4.10 | 4.20 | YES |
| T4066-3 | 4.00 | 4.10 | 4.20 | 4.00 | 4.10 | 4.20 | YES |
| T4066-4 | 4.00 | 4.10 | 4.20 | 4.00 | 4.10 | 4.20 | NO |
| T4066-5 | 4.00 | 4.10 | 4.20 | 4.00 | 4.10 | 4.20 | NO |
| T4866-1 | 4.20 | 4.30 | 4.40 | 4.20 | 4.30 | 4.40 | YES |

NOTES:

1. DIMENSIONING \& TOLERANCING CONFORM TO ASME Y14.5M-1994
2. ALL DIMENSIONS ARE IN MILLIMETERS. ANGLES ARE IN DEGREES
3. N IS THE TOTAL NUMBER OF TERMINALS.
4. THE TERMINAL \#1 IDENTIFIER AND TERMINAL NUMBERING CONVENTION SHALL CONFORM TO JESD 95-1 SPP-012. DETAILS OF TERMINAL \#1 IDENTIFIER ARE OPTIONAL, BUT MUST BE LOCATED WITHIN THE ZONE INDICATED. THE TERMINAL \#1 IDENTIFIER MAY BE EITHER A MOLD OR MARKED FEATURE.
5. DIMENSION b APPLIES TO METALLIZED TERMINAL AND IS MEASURED BETWEEN 0.25 mm AND 0.30 mm FROM TERMINAL TIP.
6. ND AND NE REFER TO THE NUMBER OF TERMINALS ON EACH D AND E SIDE RESPECTIVELY
7. DEPOPULATION IS POSSIBLE IN A SYMMETRICAL FASHION.
8. COPLANARITY APPLIES TO THE EXPOSED HEAT SINK SLUG AS WELL AS THE TERMINALS.
9. DRAWING CONFORMS TO JEDEC MO220, EXCEPT FOR 0.4 mm LEAD PITCH PACKAGE T4866-1.
10. WARPAGE SHALL NOT EXCEED 0.10 mm .


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